

Platform : CFL_H+N17E-G1

1.	INDEX	40.	VCC SW
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5.	CPU SKL-H : DDR4 CH-A	44.	TP/LED/WEBCAM/USB
6.	CPU SKL-H : DDR4 CH-B	45.	Intel Lan(I217)
7.	CPU SKL-H : PEG/DMI	46.	GFX-PCIE
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18.	PCH SKL-H : SATA/PCIE	57.	BIOS,XTAL ,External SS ,M
19.	PCH SKL-H : AUDIO/SMBUS/JTAG	58.	GPIO, Thermal Sensor, I2C
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23.	PCH SKL-H : POWER	62.	change list2
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28.	EDP		
29.	HDMI		
30.	EC IT8528E/BIOS/KB CONN		
31.	PSW/HIGH-SPEED		
32.	HDD/ODD /MINI CARD		
33.	LAN RTL8118AG		
34.	CODEC(ALC269Q)/INT MIC/SPKR		
35.	EXT_MIC/USB/FAN/G-sen		
36.	BATT IN/CHARGER(OZ8690)		
37.	DC IN/TPM/D-Resis/HOLE		
38.	+5VA/+3.3VA		
39.	+1.0VA_PCH/VCCIO		

[illegible][illegible]

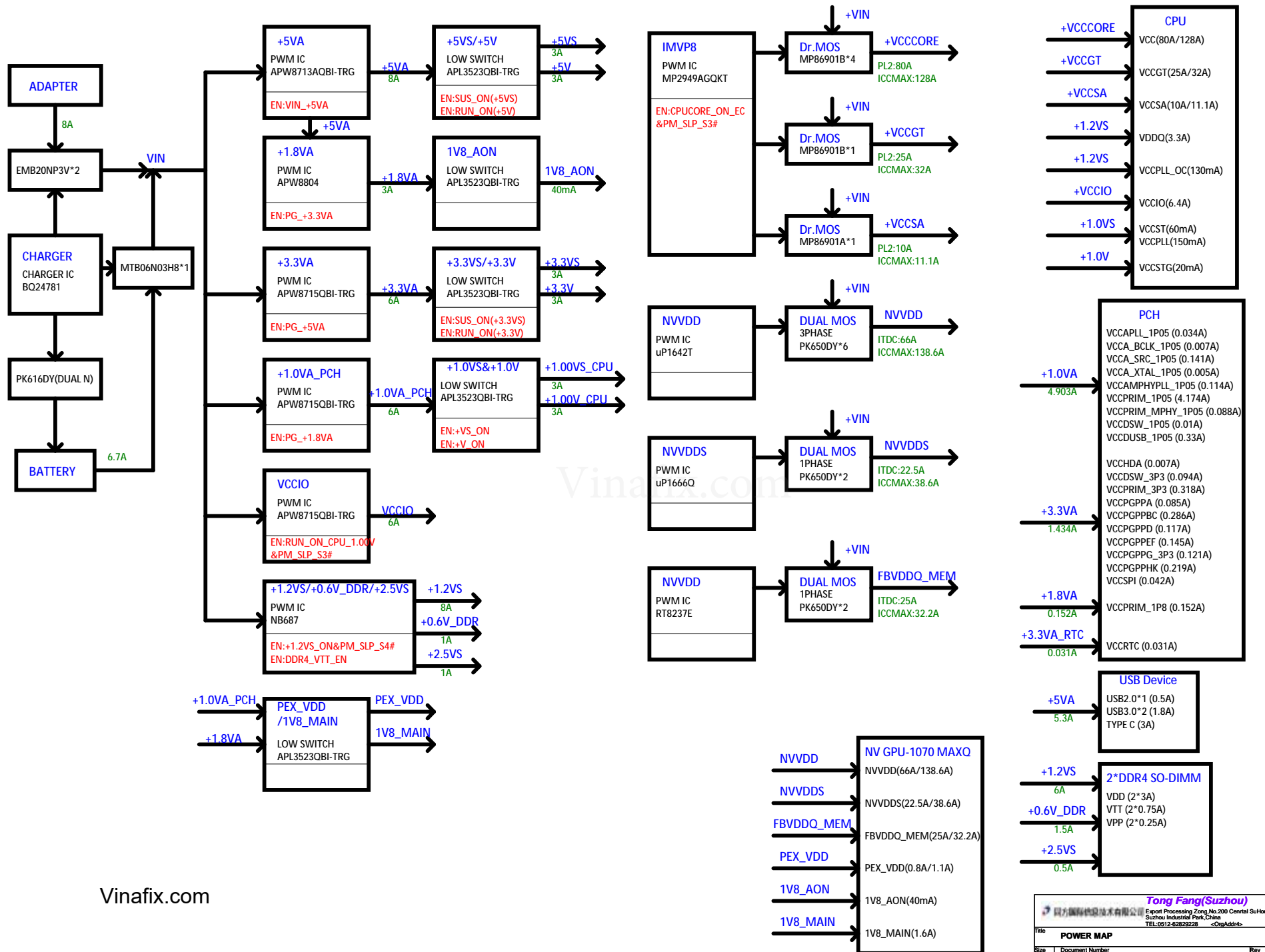
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		INDEX	
Size	Document Number	Rev	
Custom	GKSCN6X	VA	
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SYSTEM BLOCK DIAGRAM

POWER ON SEQUENCE

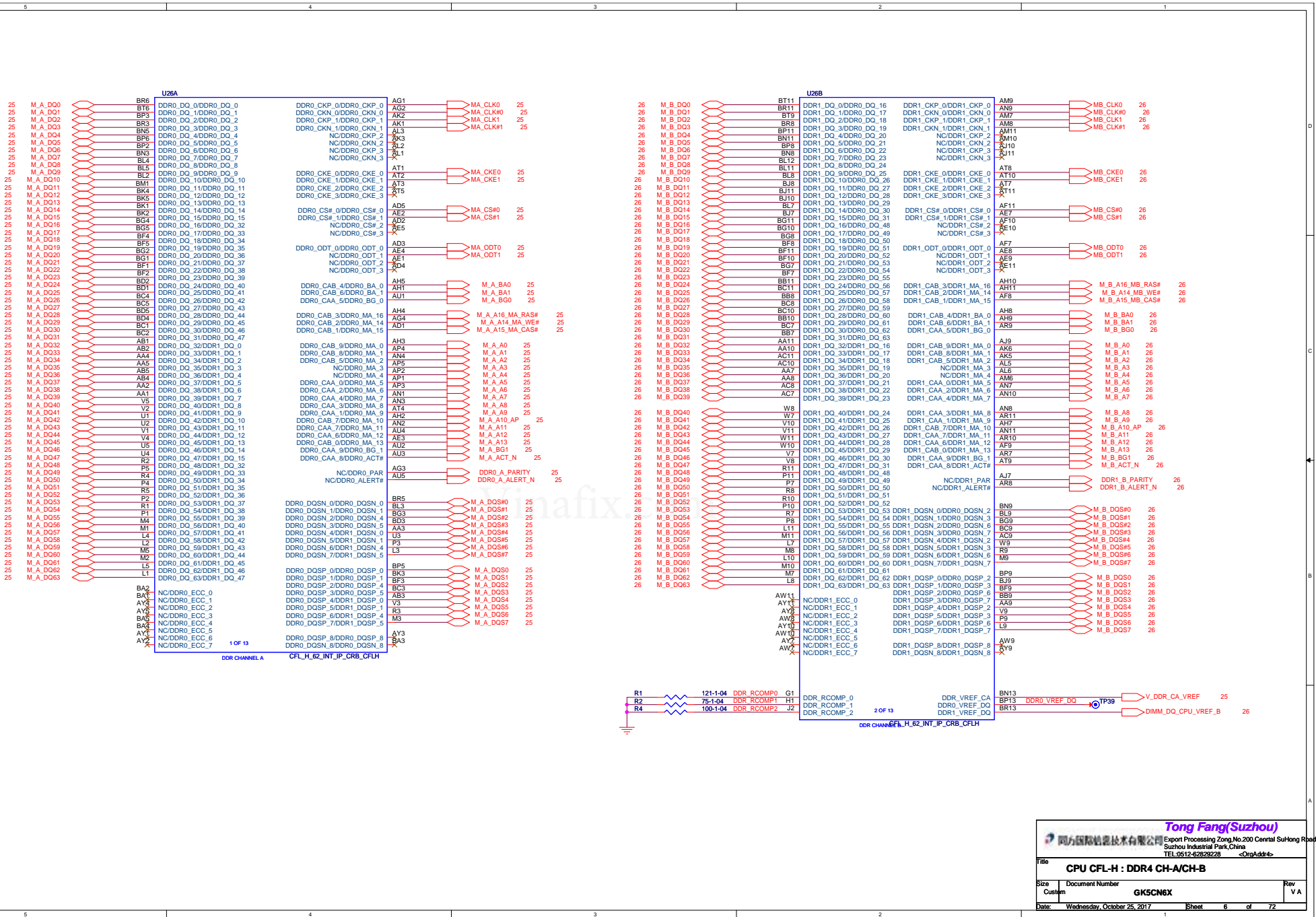
TPCH3.4
All PCN Primary Rails
should ramp up within 20ms.





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Title: POWER MAP			
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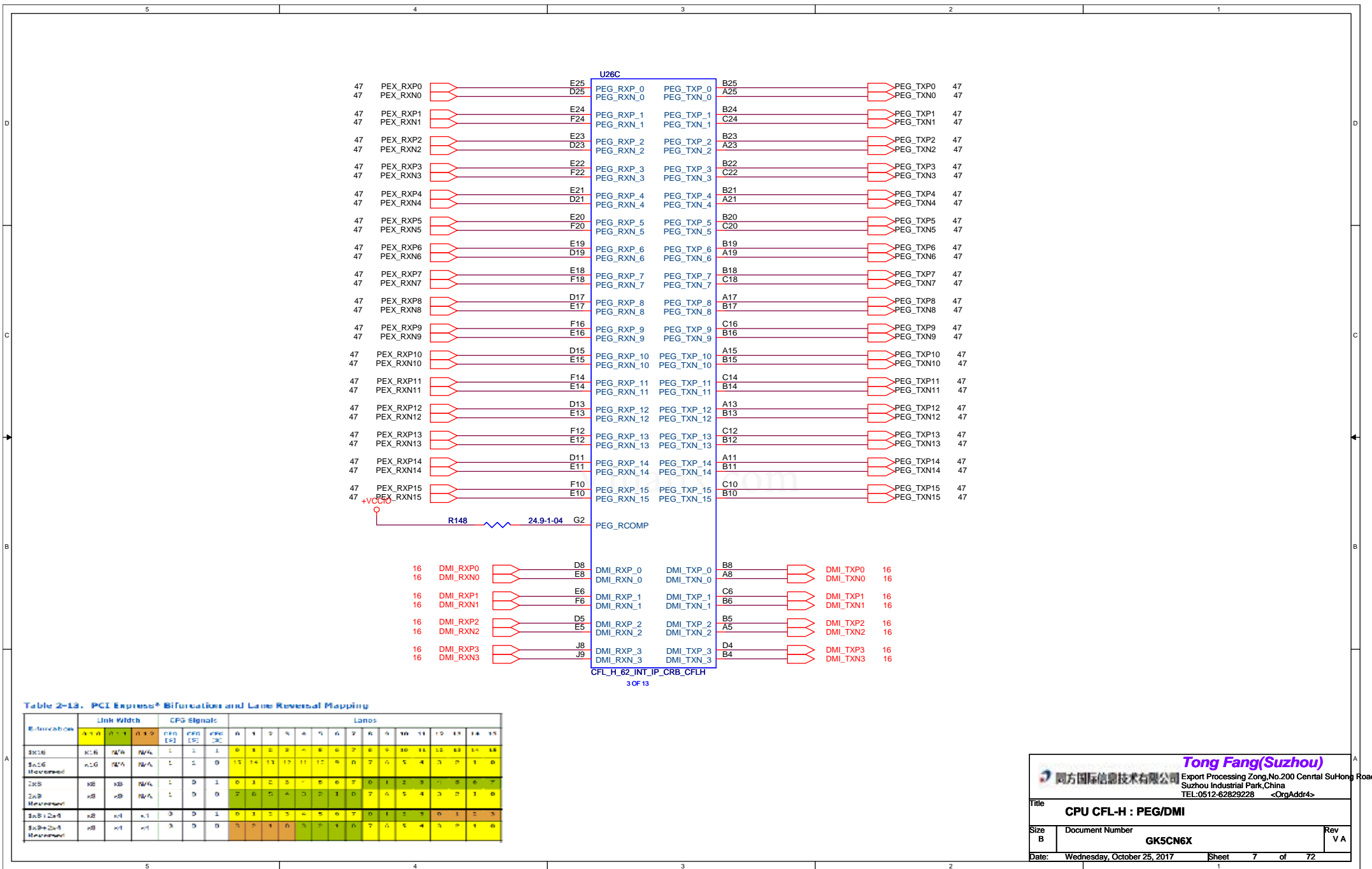


Table 2-13. PCI Express® Bifurcation and Lane Reversal Mapping

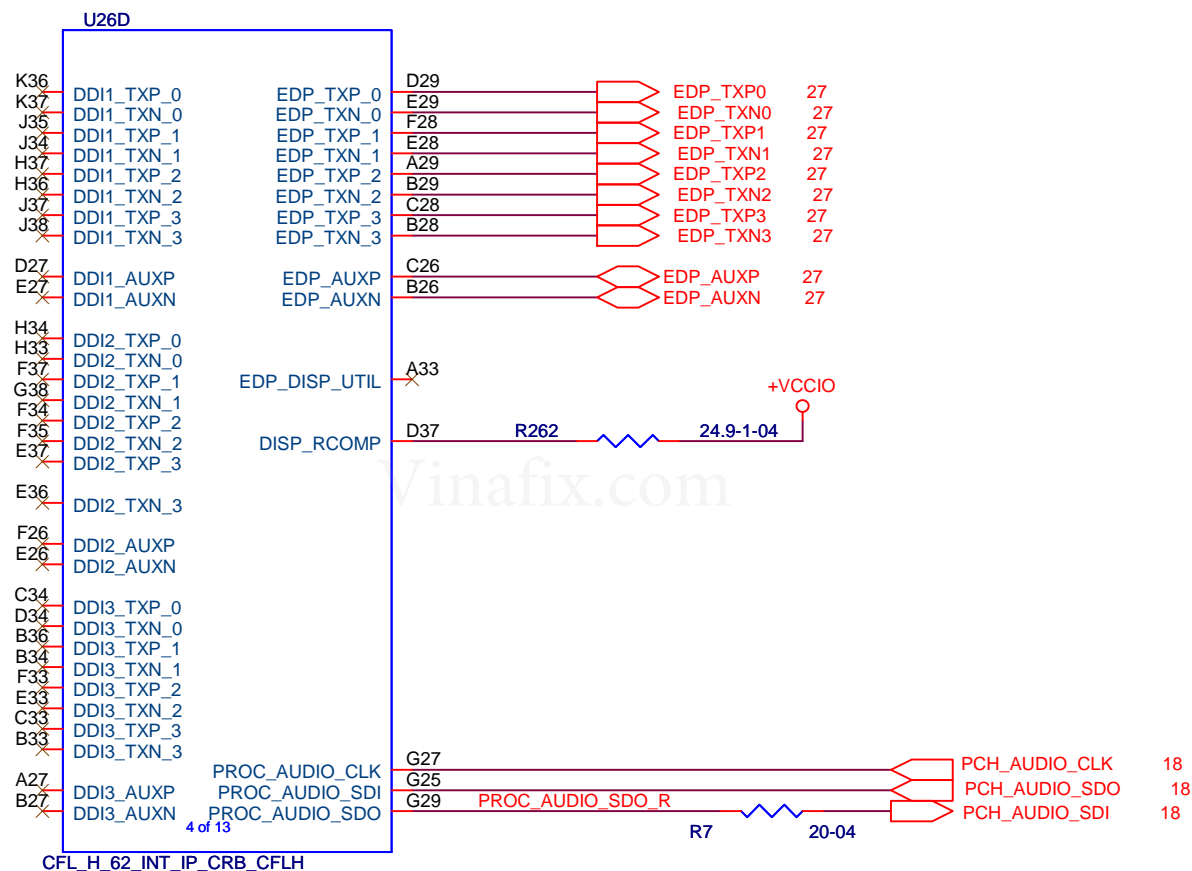
Bifurcation	Link Width			CFG Signals			Lanes															
	W1	W2	W3	W4	W5	W6	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
8x0E	8x0E	8x0E	8x0E	8x0E	8x0E	8x0E	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
8x0E Reversed	8x0E	8x0E	8x0E	8x0E	8x0E	8x0E	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
2x8	2x8	2x8	2x8	2x8	2x8	2x8	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
2x8 Reversed	2x8	2x8	2x8	2x8	2x8	2x8	7	6	5	4	3	2	1	0	15	14	13	12	11	10	9	8
8x0E + 2x8	8x0E	2x8	2x8	2x8	2x8	2x8	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
8x0E + 2x8 Reversed	8x0E	2x8	2x8	2x8	2x8	2x8	7	6	5	4	3	2	1	0	15	14	13	12	11	10	9	8

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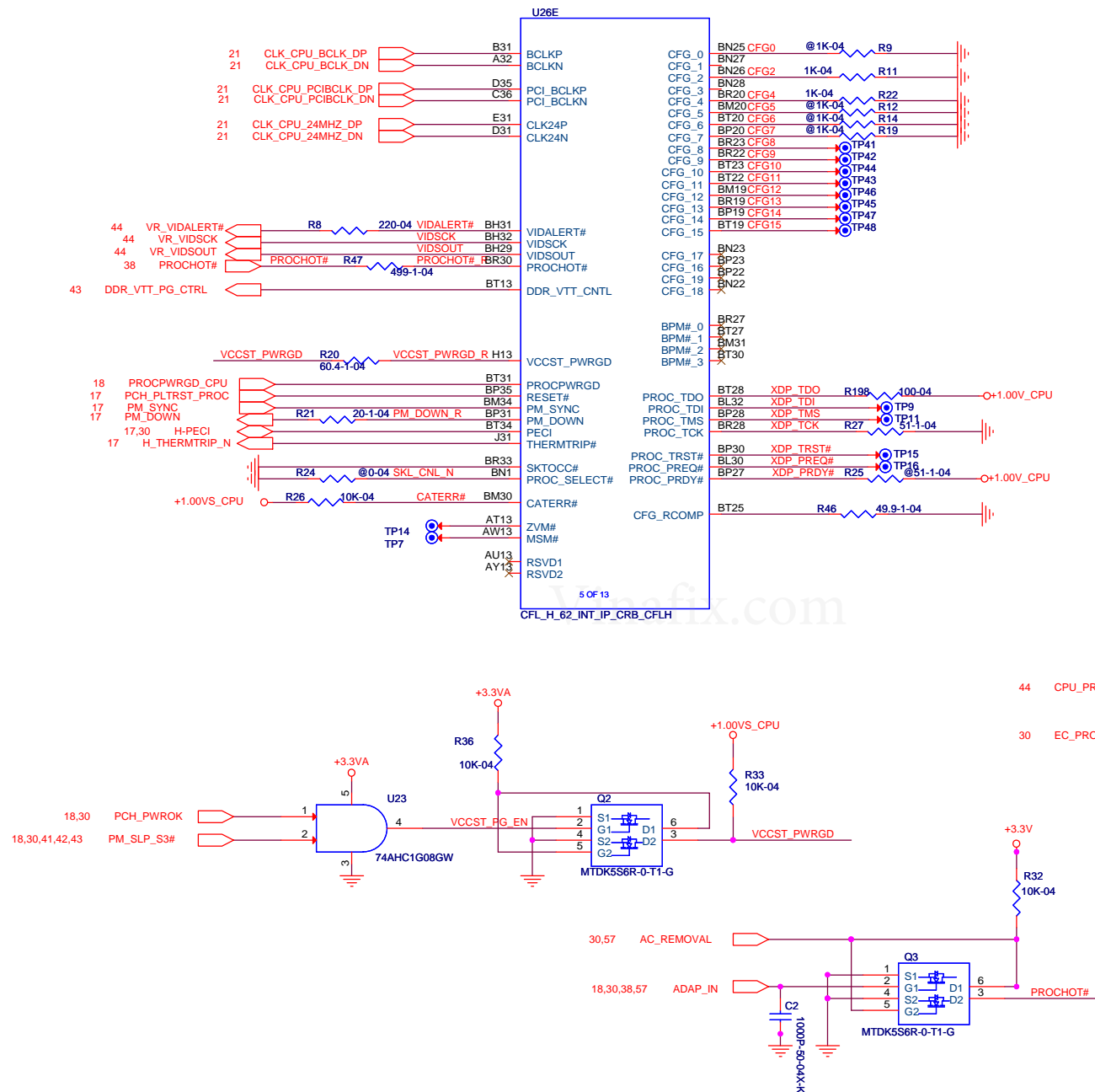
Title: **CPU CFL-H : PEG/DMI**

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Title CPU CFL-H : DDI/EDP	
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Intel recommends placing test points on the board for CFC pins.

- **CFG[0]:** Shall reset sequence after PCU P1 lock until de-asserted:
1 = (Default) Normal Operation, No stall.
0 = Stall.
- **CFG[1]:** Reserved configuration lanes.
- **CFG[2]:** PCI Express® Static x16 Lane Numbering Reversal.
1 = Normal operation
0 = Lane numbers reversed.
- **CFG[3]:** Reserved configuration lanes.
- **CFG[4]:** eDP enable:
1 = Disabled.
0 = Enabled.
- **CFG[5]:** PCI Express® Biturcation
00 = 1 x8, 2 x4 PCI Express®
01 = reserved
10 = 2 x8 PCI Express®
11 = 1 x16 PCI Express®
- **CFG[7]:** PFG Training:
1 = (Default) PFG Train immediately following R1 S1# de-assertion.
0 = PFG Wait for RTOS for training.
- **CFG[198]:** Reserved configuration lanes.

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Title CPU CFL-H: MISC/CLK/JTAG/CFG		
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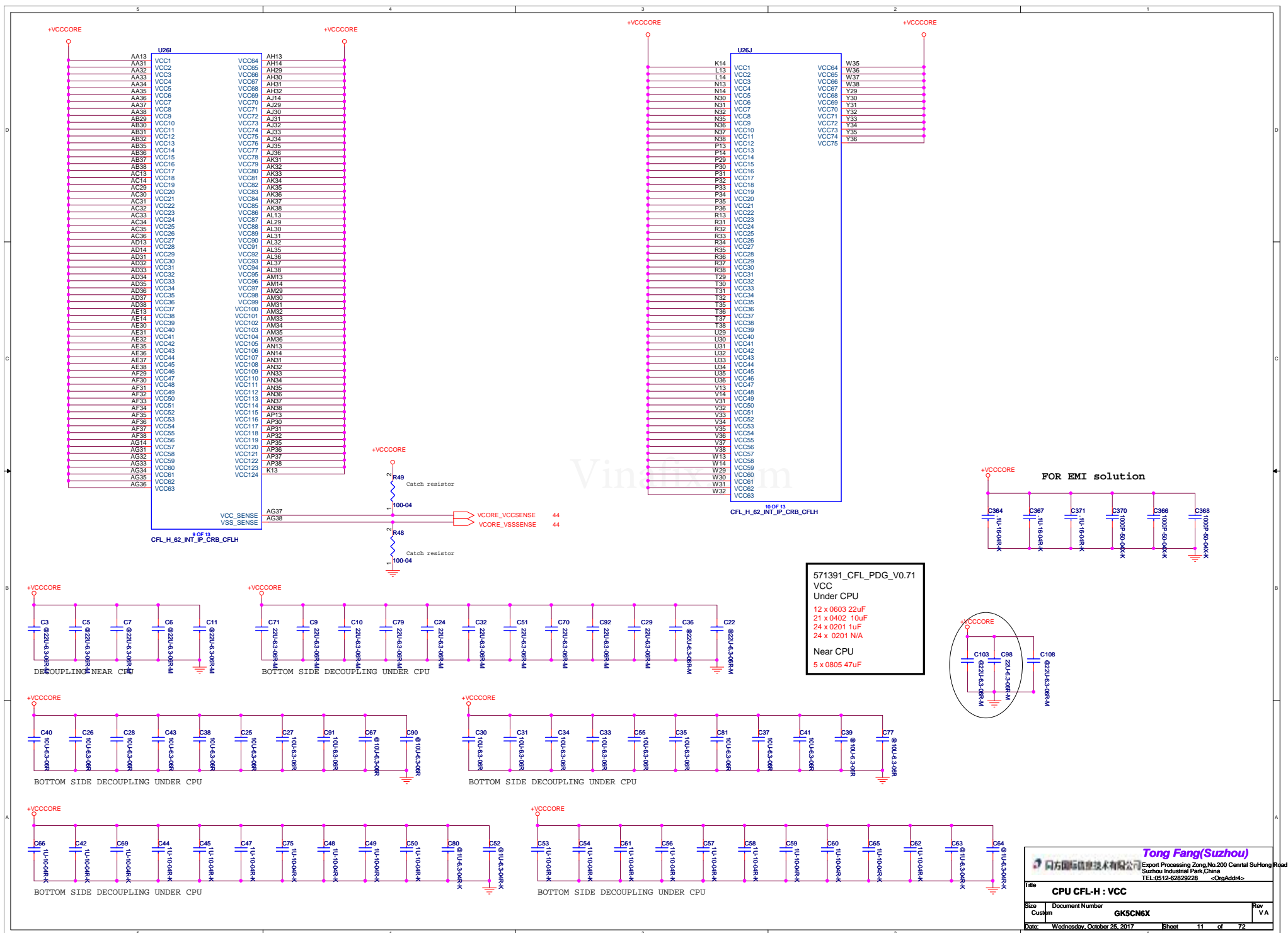


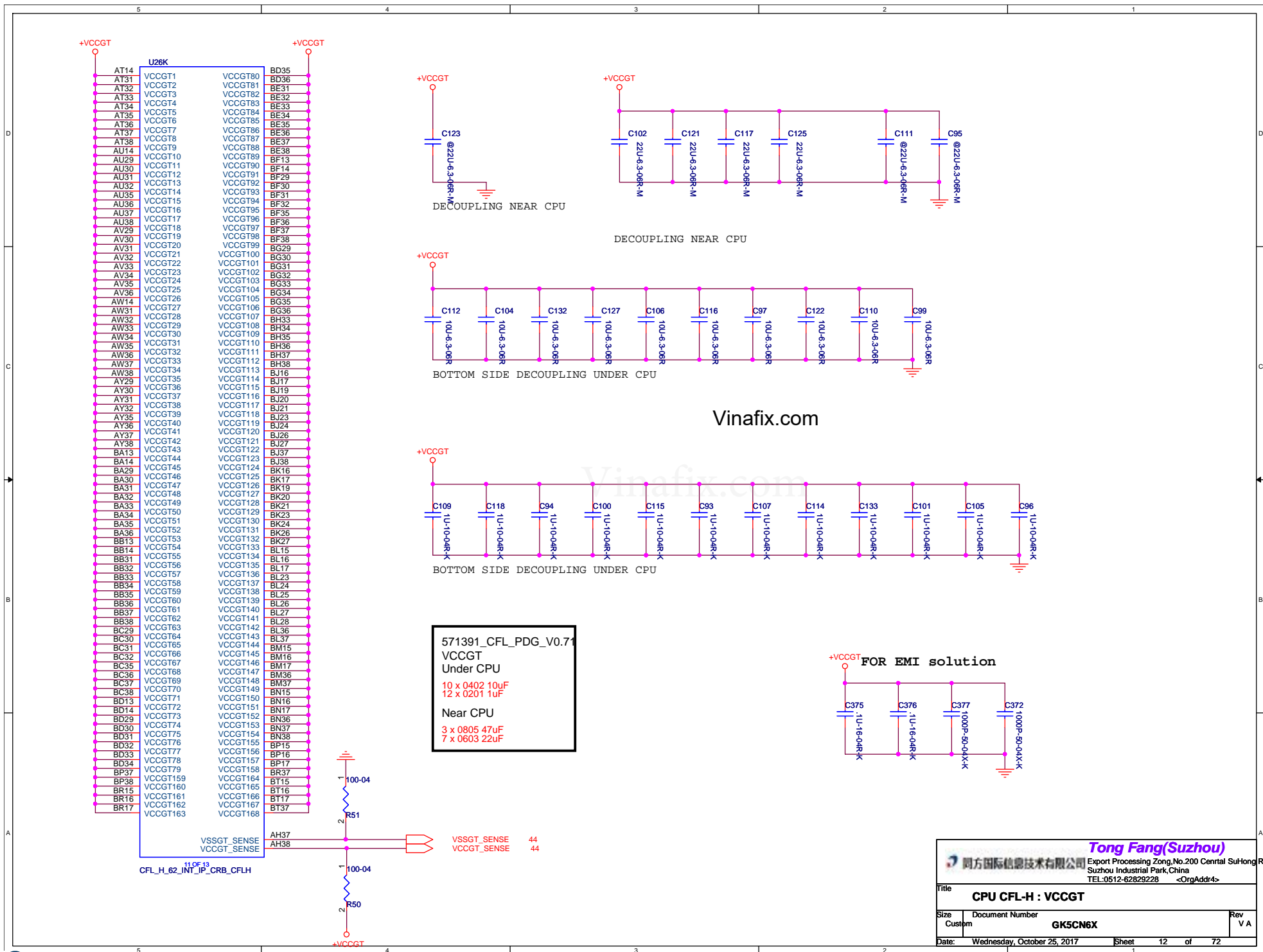
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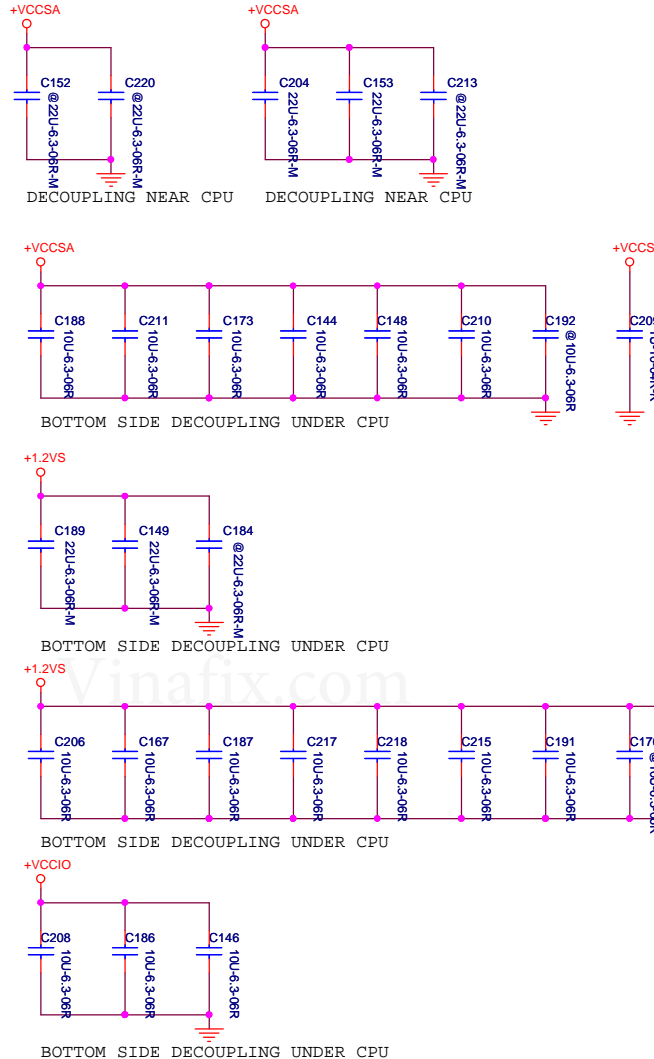
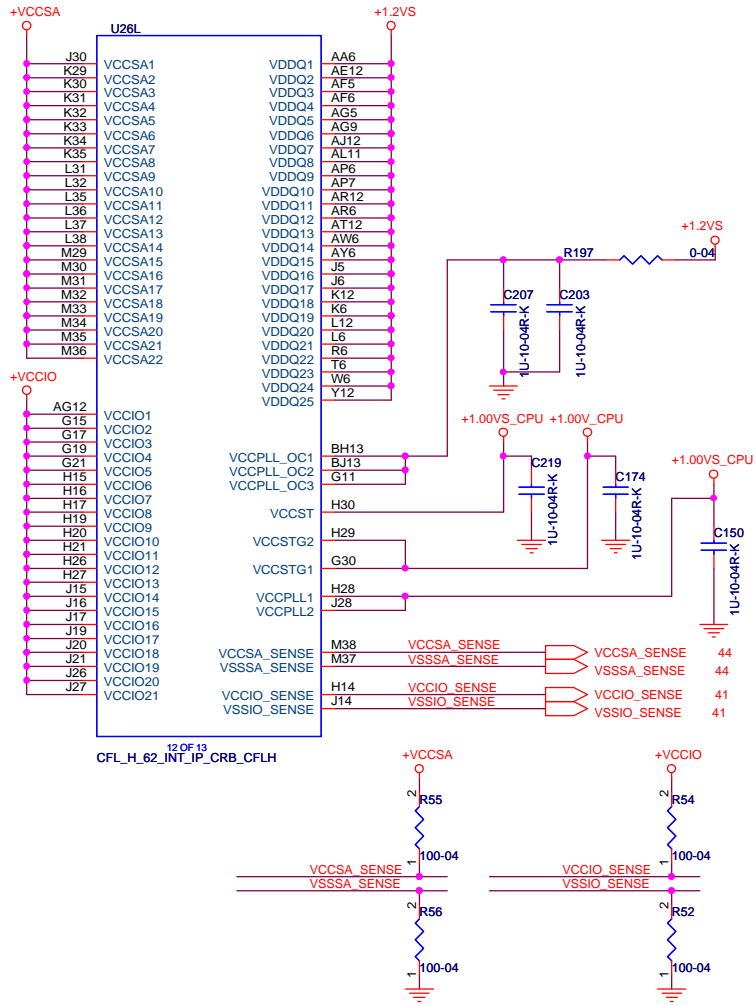
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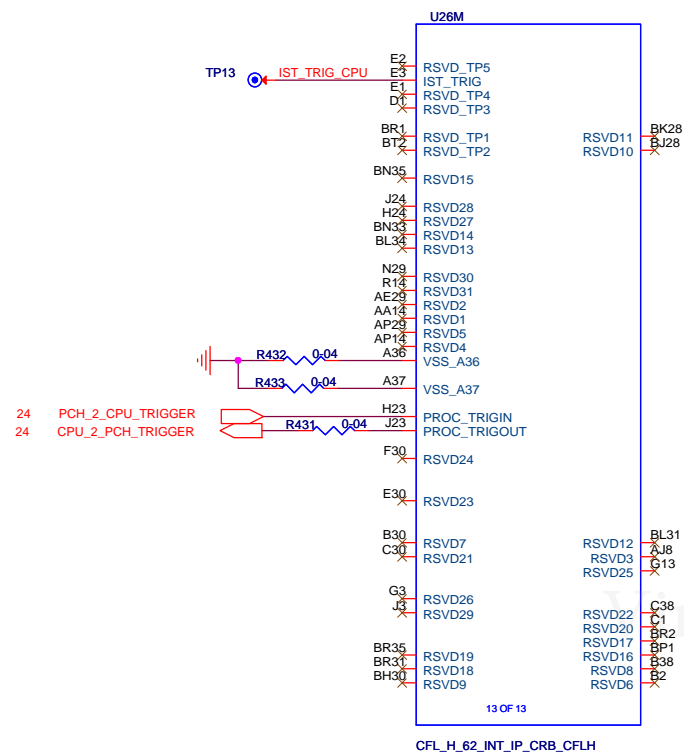



571391_CFL_PDG_V0.71	
VCCSA	VCCST
Under CPU	Under CPU
7 x 0402 10uF	1 x 0201 1uF
1 x 0201 1uF	
Near CPU	VCCSTG
2 x 0805 47uF	Under CPU
2 x 0603 22uF	1 x 0201 1uF
VDDQ	VCCPLL
Under CPU	Under CPU
4 x 0603 22uF	1 x 0201 1uF
11 x 0402 10uF	
VCCIO	VCCPLL_OC
Under CPU	Under CPU
3 x 0402 10uF	2 x 0201 1uF
3 x 0402 N/A	

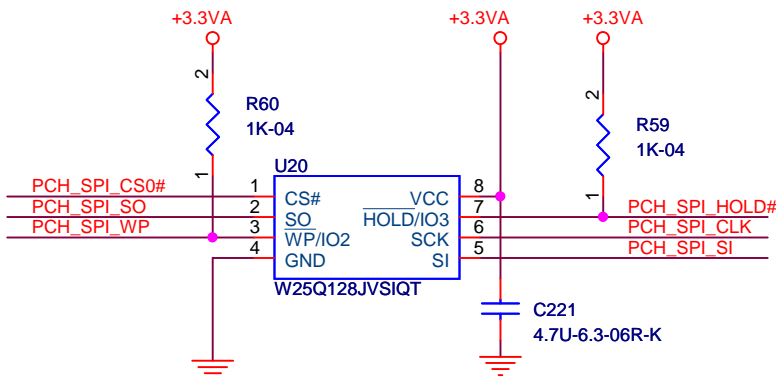
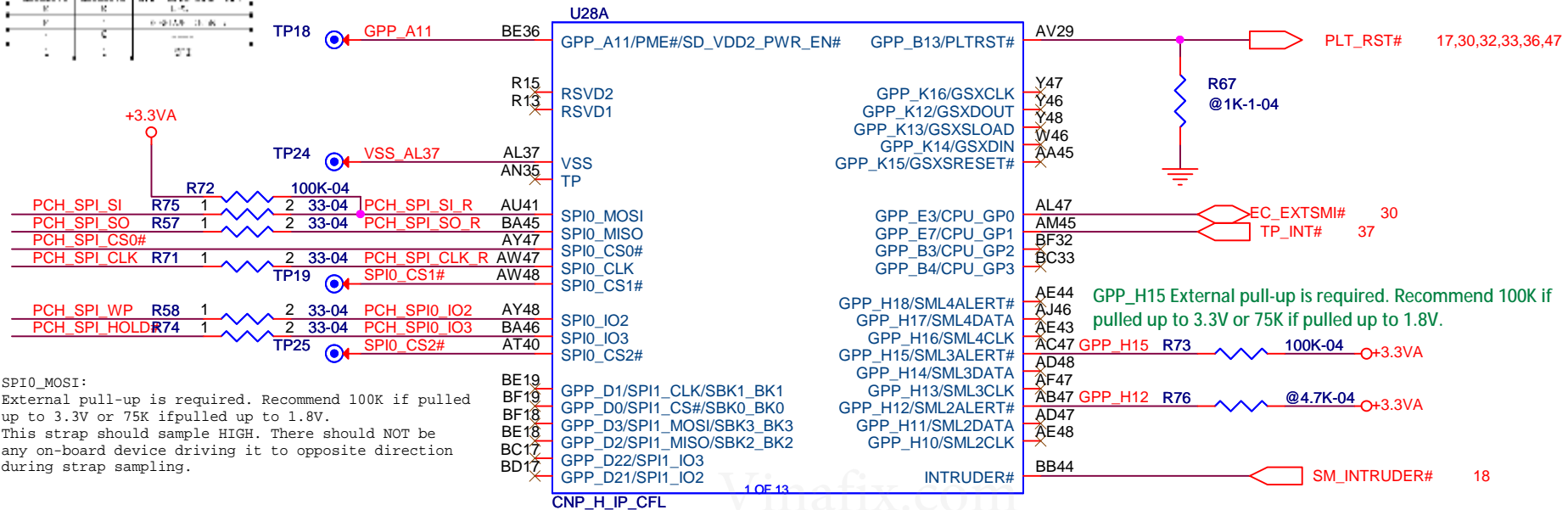
FOR EMI solution

FOR EMI solution

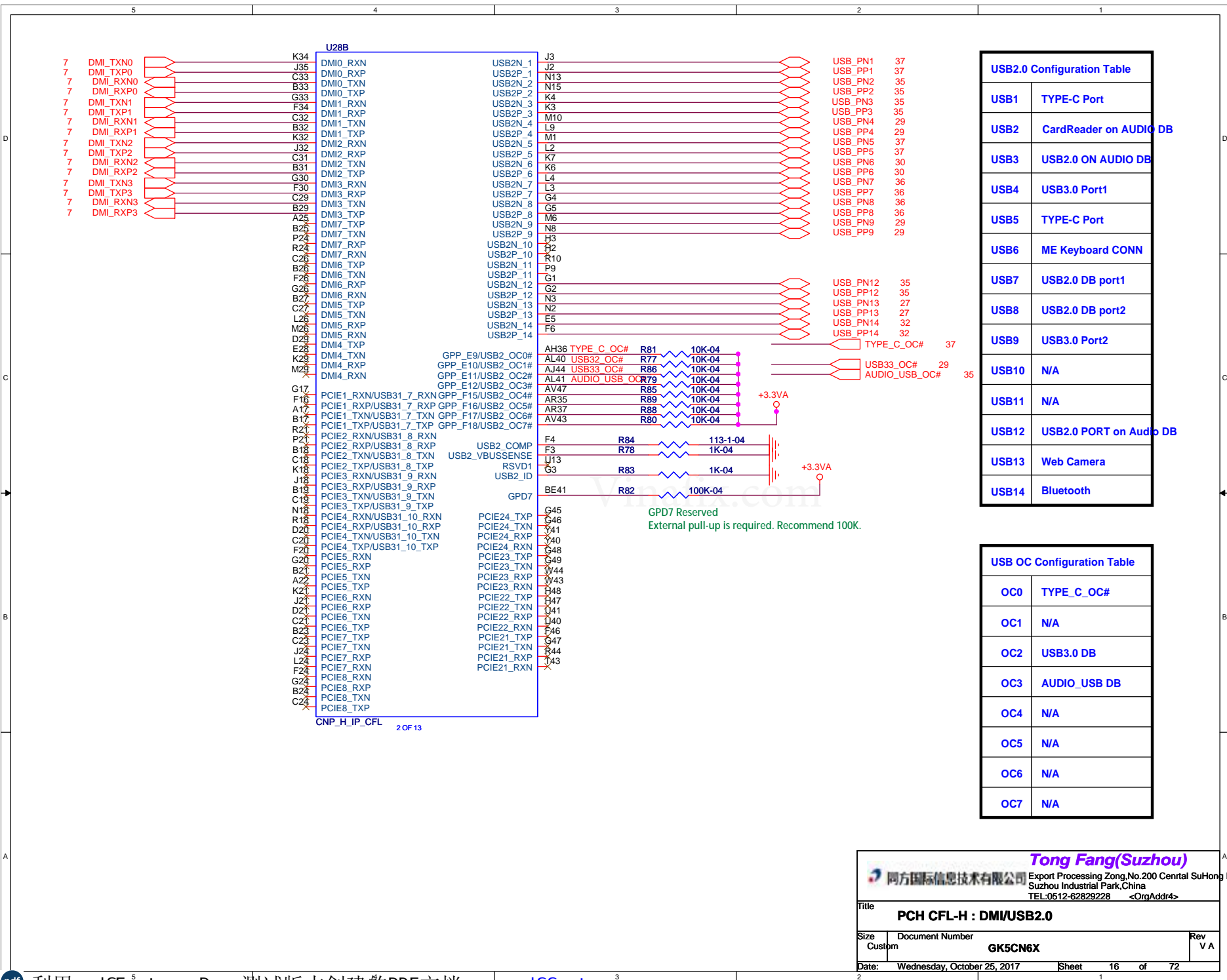
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Title	
CPU CFL-H : VCCSA/VCCIO/VDDQ	
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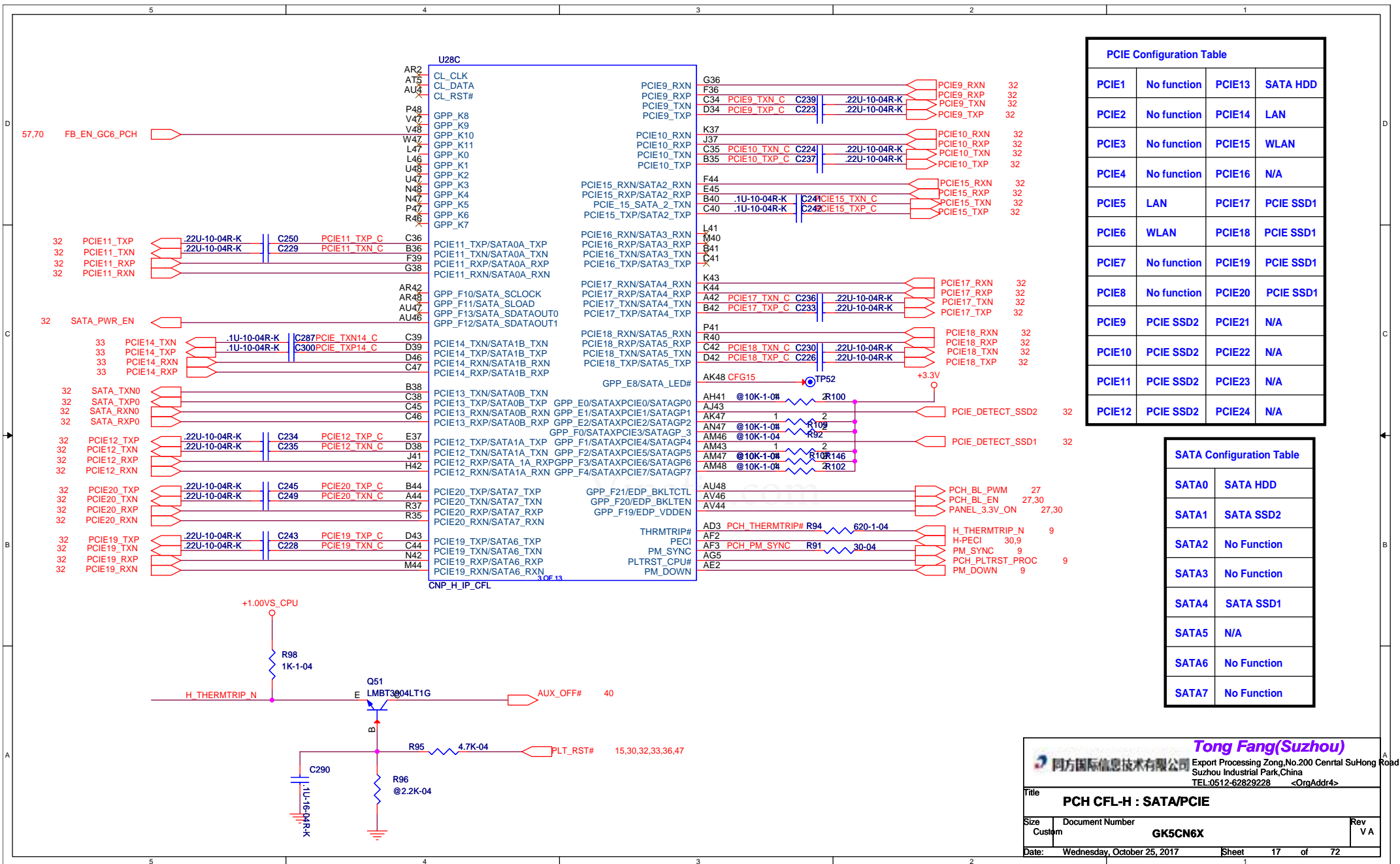


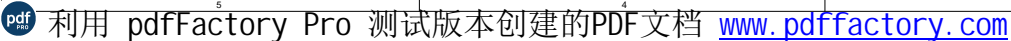
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Title CPU CFL-H : TRIG/RSVD	
Size B	Document Number GK5CN6X
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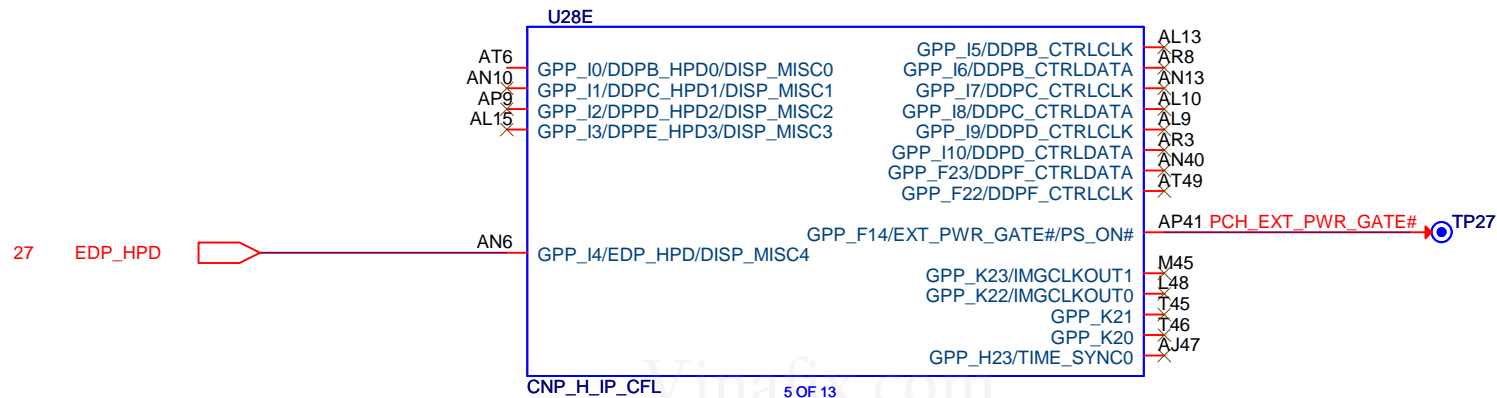


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Title PCH CFL-H : SPI	
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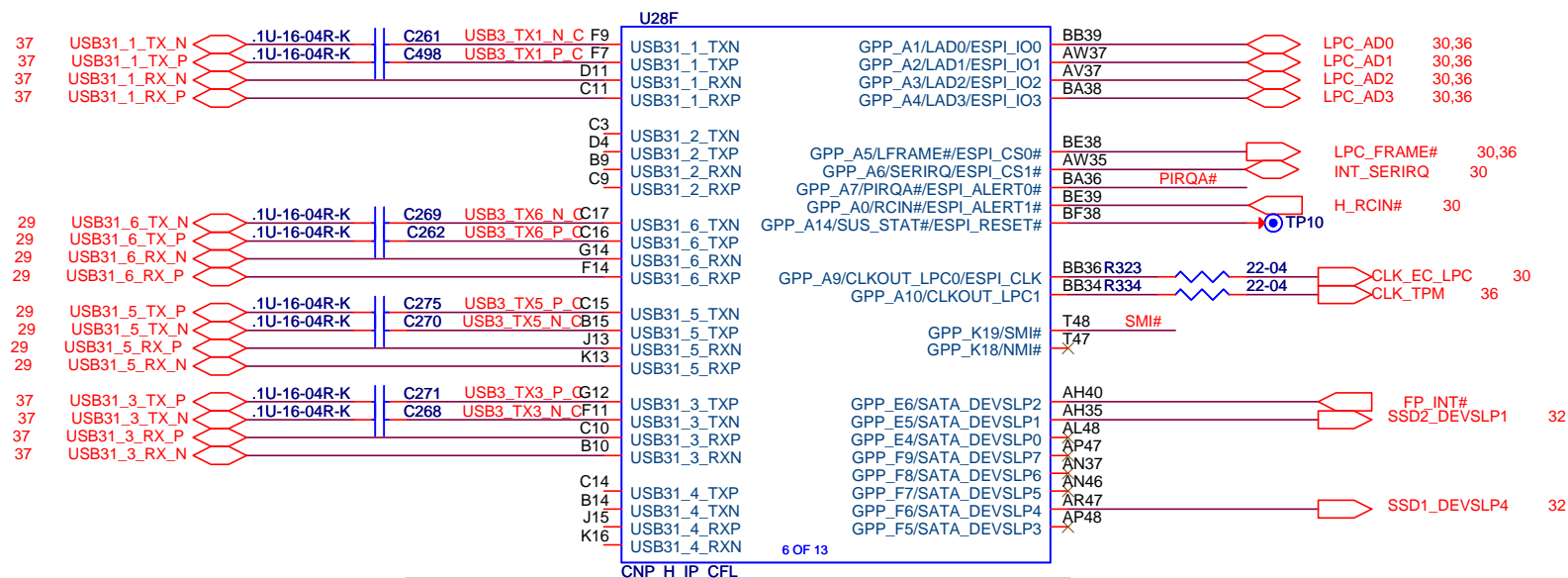






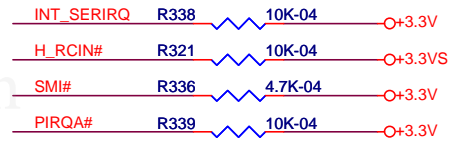


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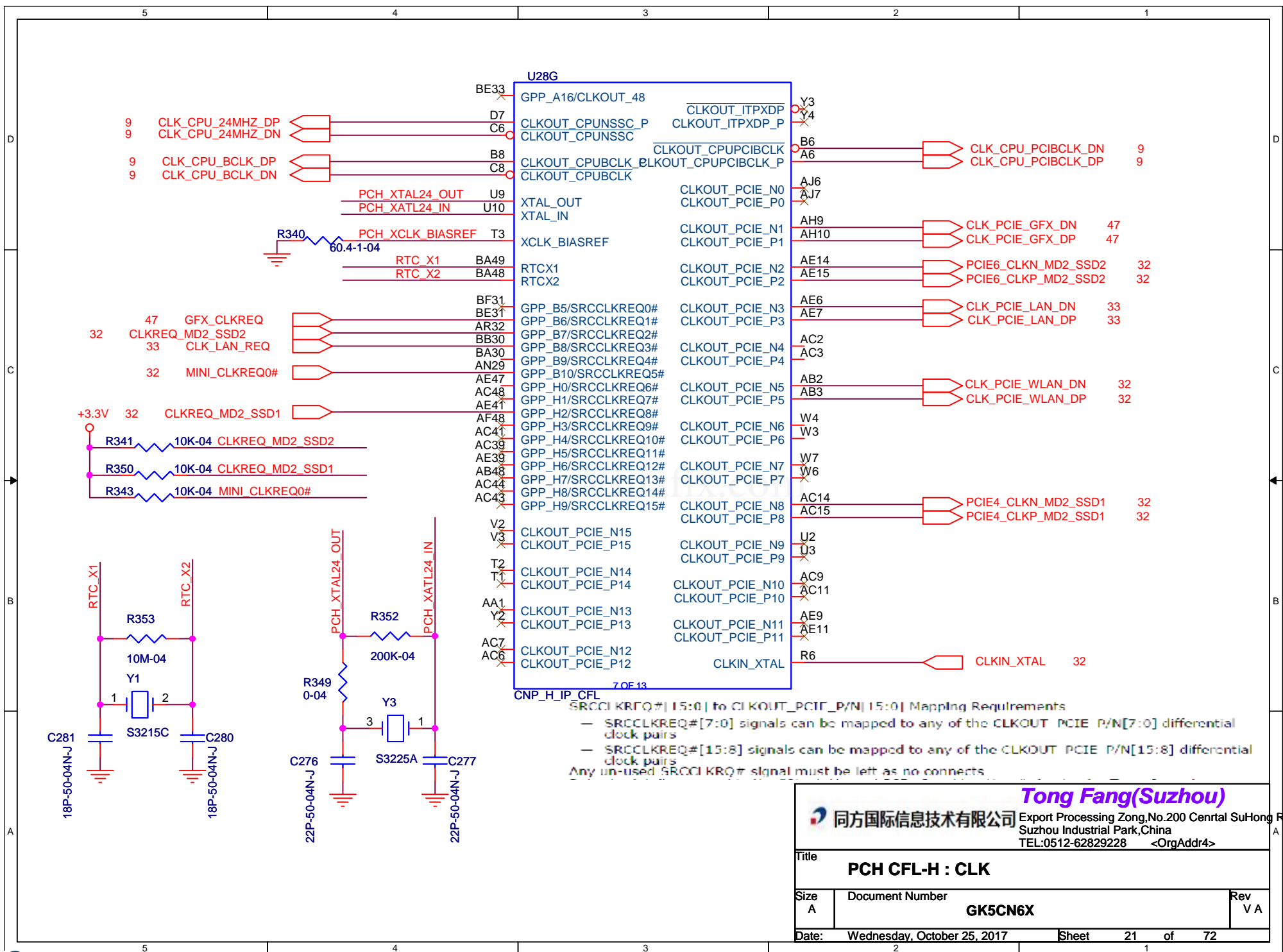


USB3.0 Configuration Table	
USB3_1	TYPE-C
USB3_2	N/A
USB3_3	TYPE-C
USB3_4	N/A
USB3_5	USB3.0 Port2
USB3_6	USB3.0 Port1
USB3_7	N/A
USB3_8	N/A
USB3_9	No Function
USB3_10	No Function

Change +3.3V to 3VS in order to prevent leakage to +3.3V under S3
RC_IN : VSTBY power plane in EC



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Title PCH CFL-H : USB3.0/LPC	
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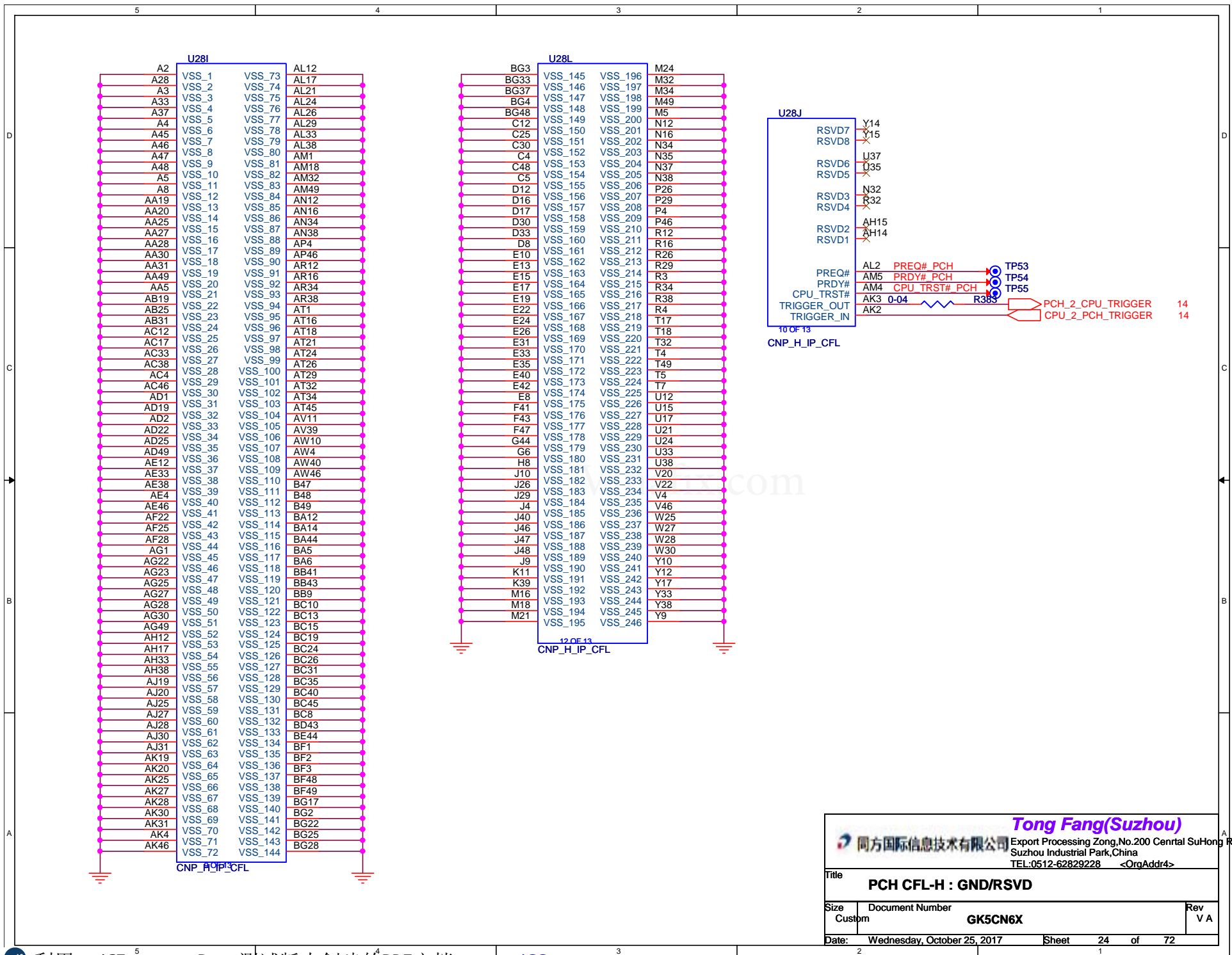


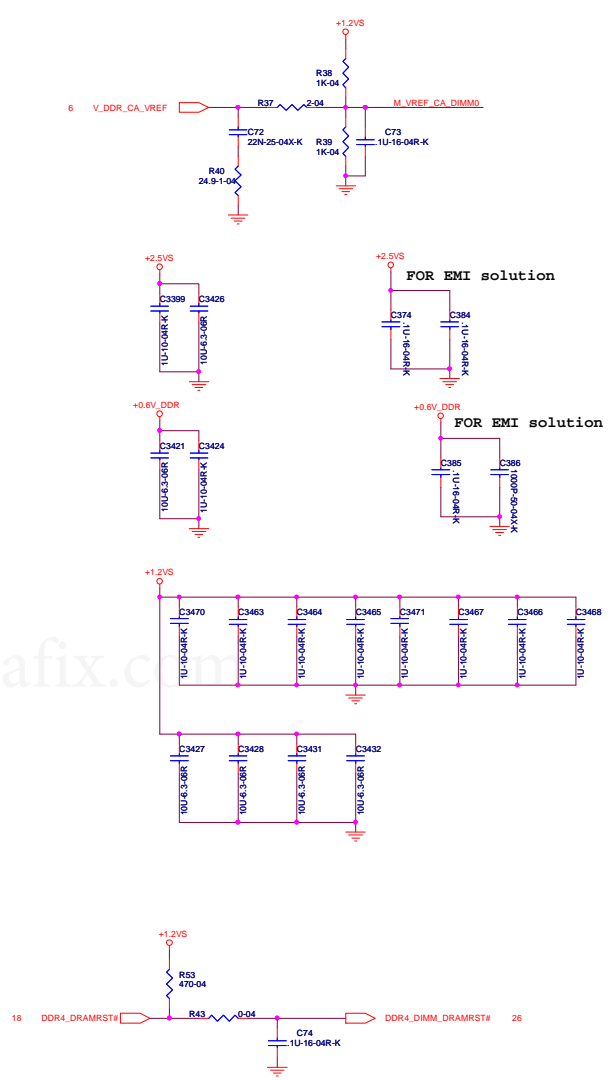
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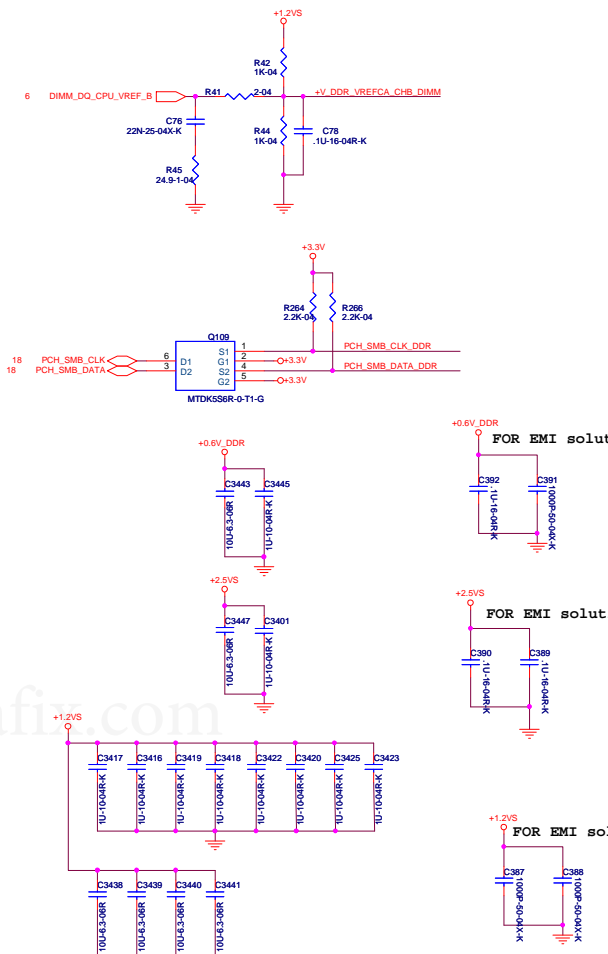
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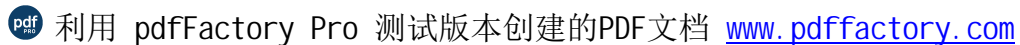
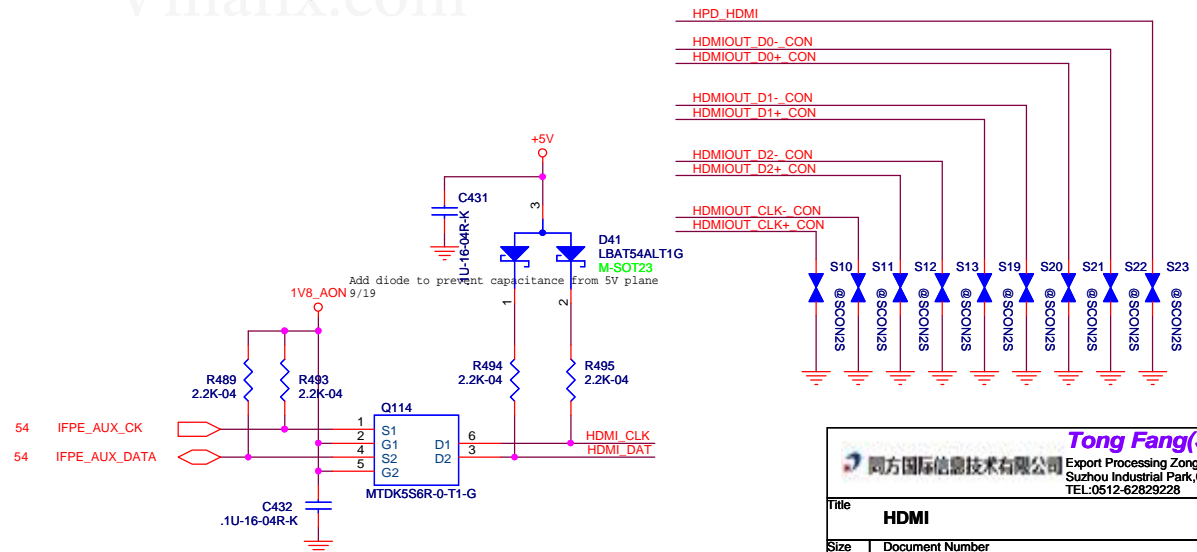




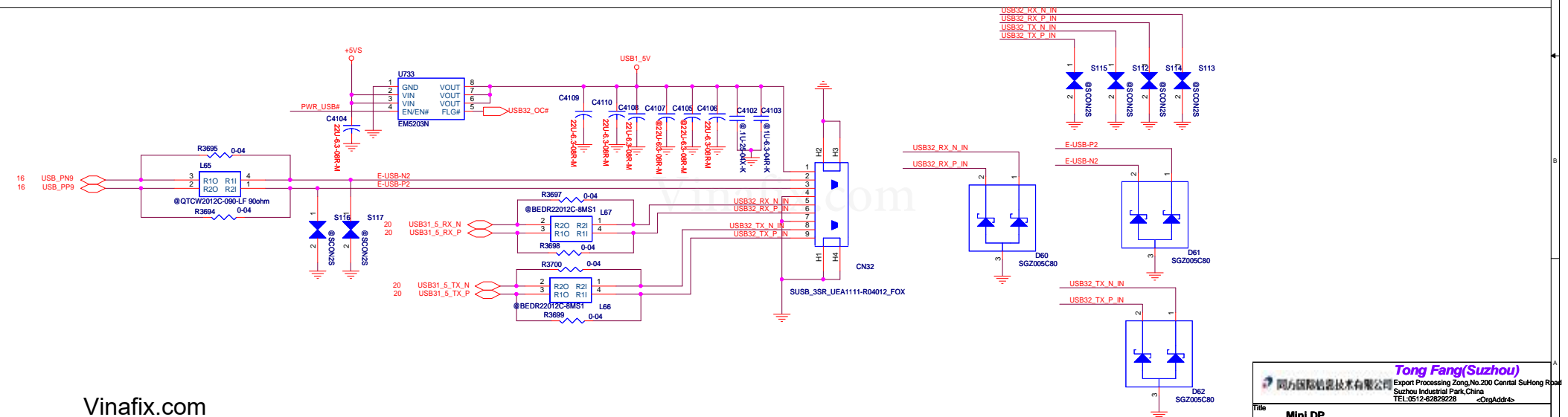
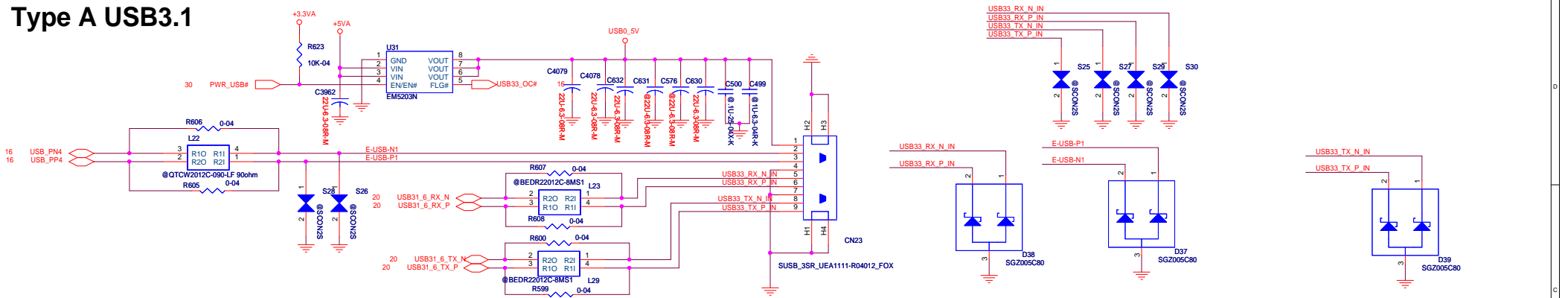


Main

```
HDMI R2.0 670MHz NV Supported
HDMI R1.4 340MHz Intel Supported
```



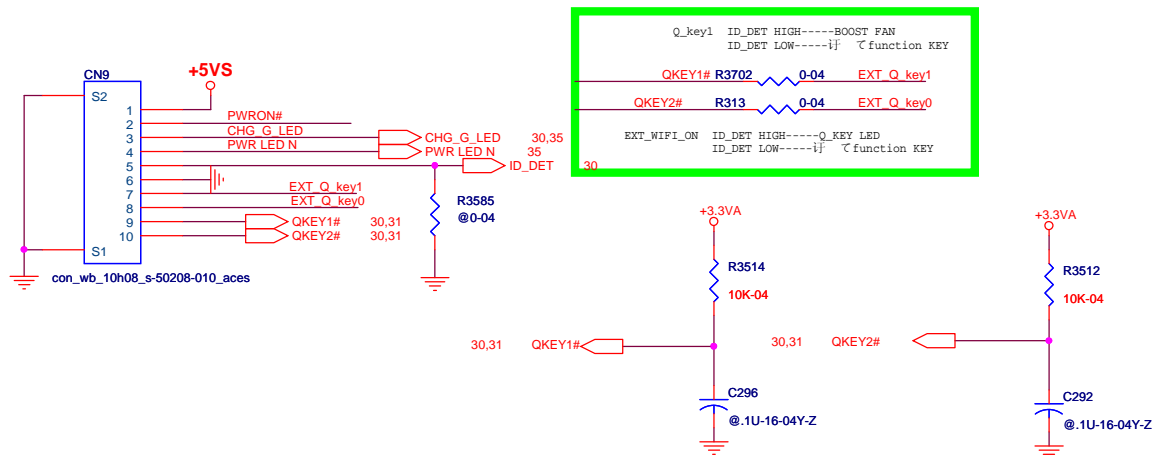
Type A USB3.1



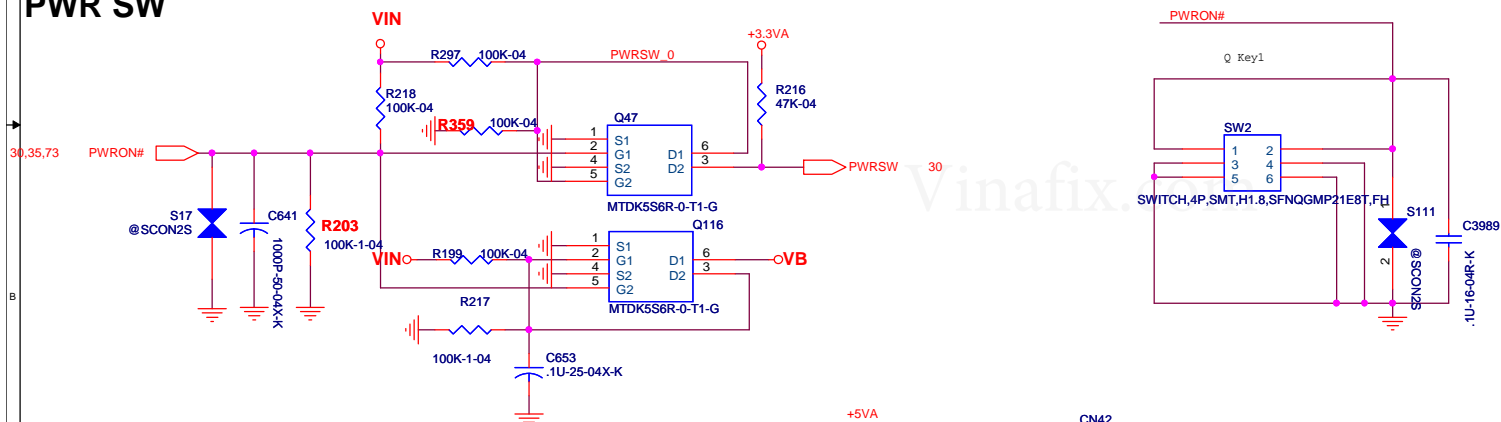
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		<Omgkde>		
Title				
Mini DP				
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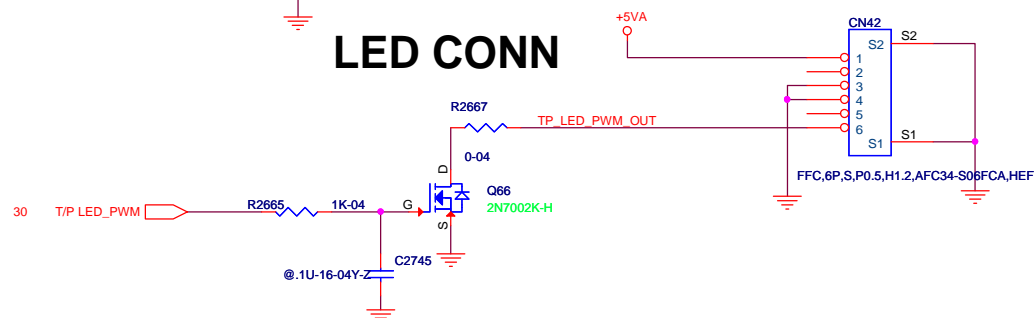
POWER DB CONN.



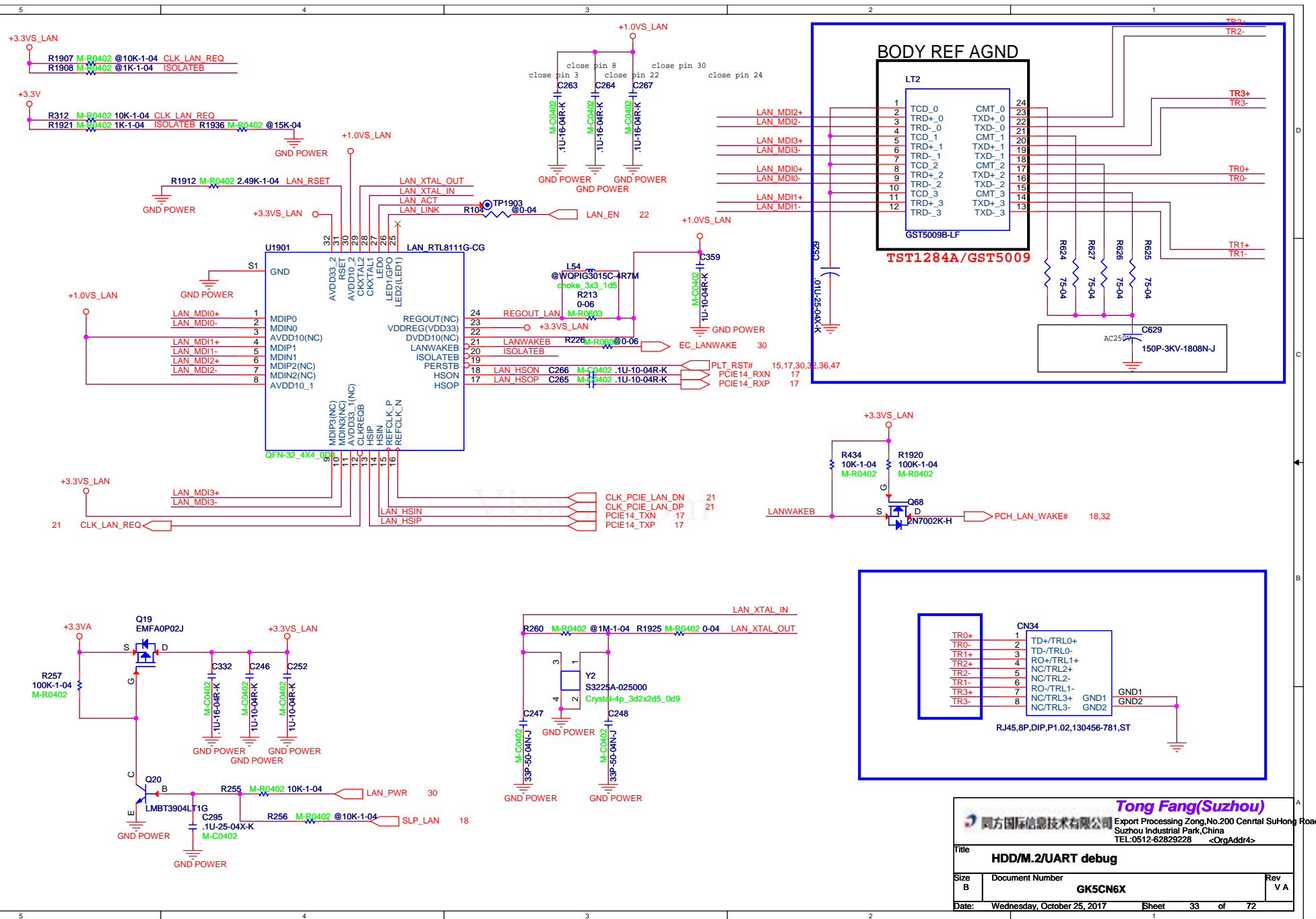
PWR SW



LED CONN



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Title PSW/PWR DB CON	
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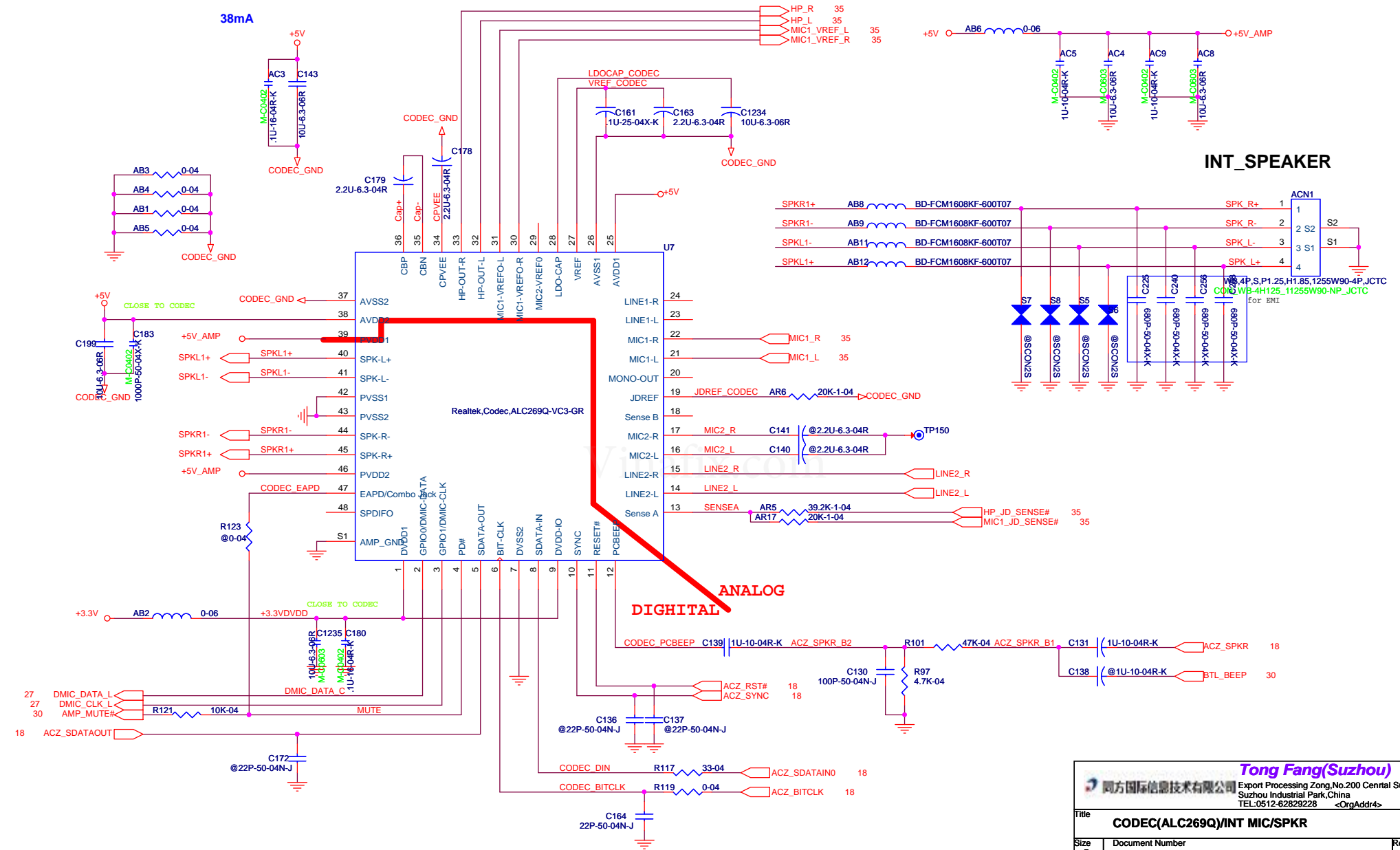


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Title	HDD/M.2/UART debug
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CODEC ALC269Q

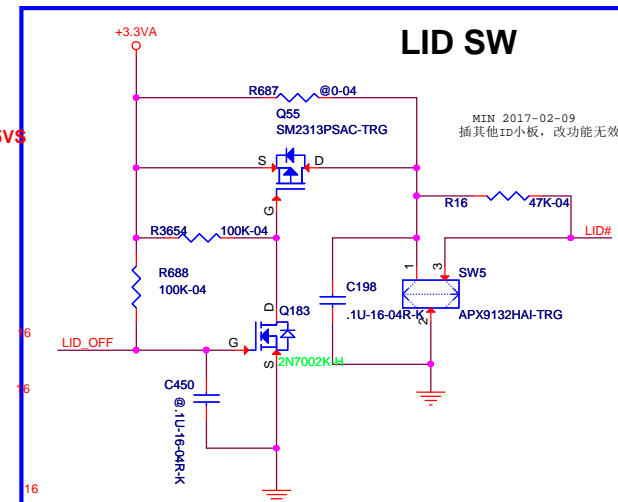
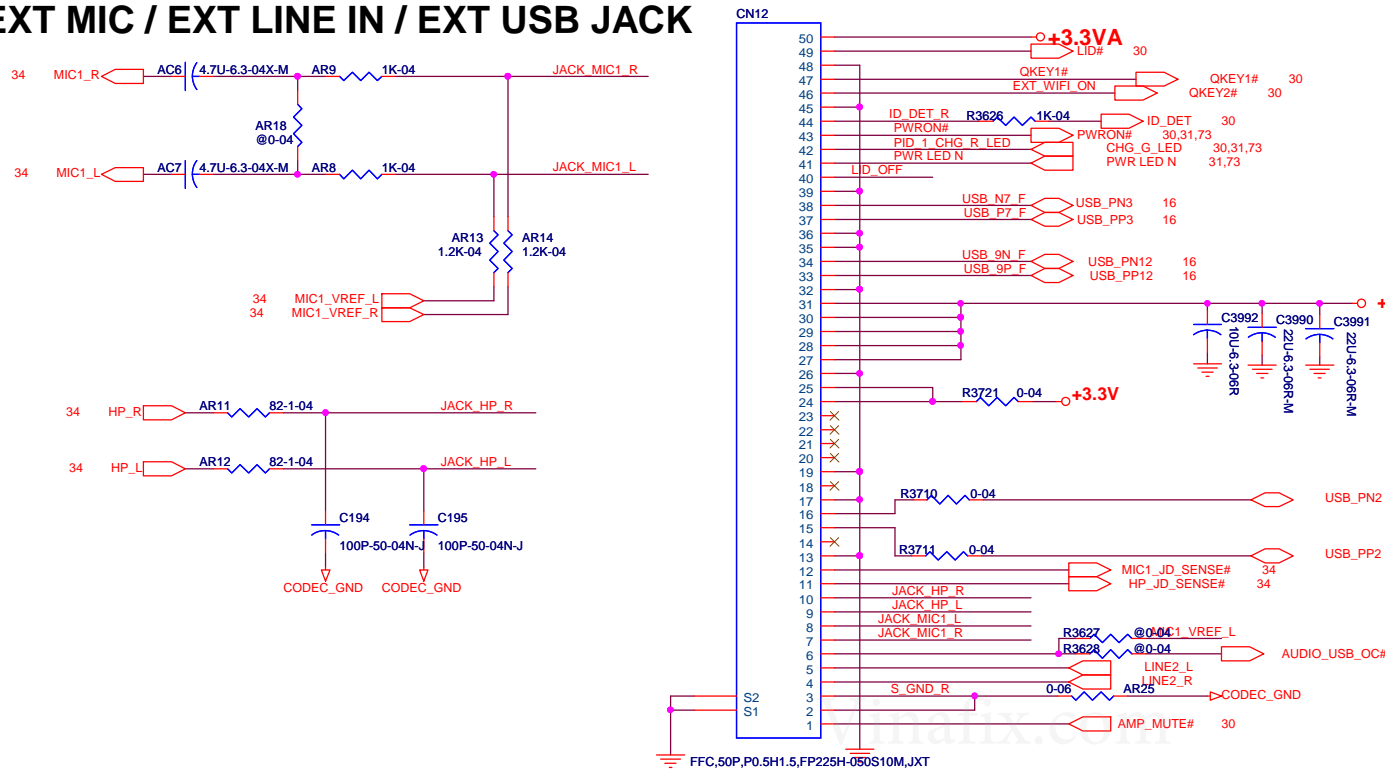
AMP VDD

INT_SPEAKER



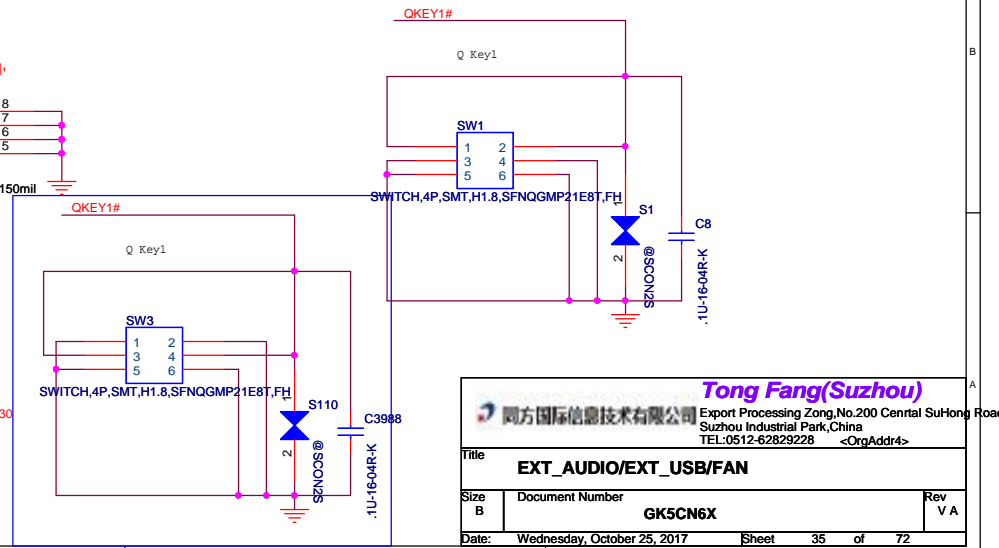
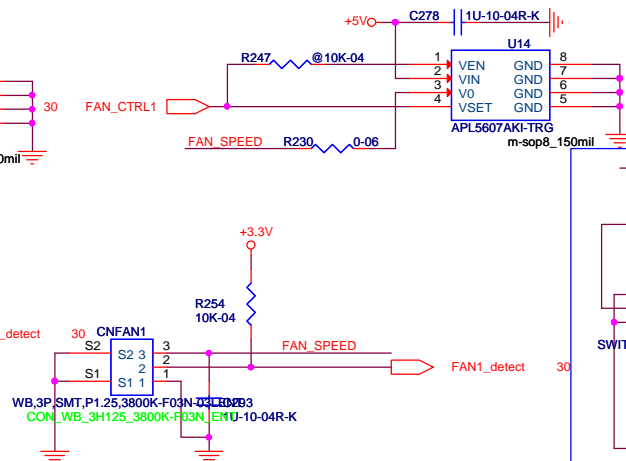
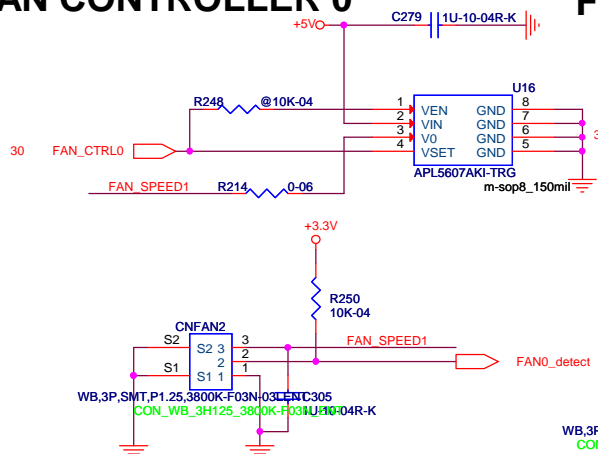
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Title	CODEC(ALC269Q)INT MIC/SPKR
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EXT MIC / EXT LINE IN / EXT USB JACK



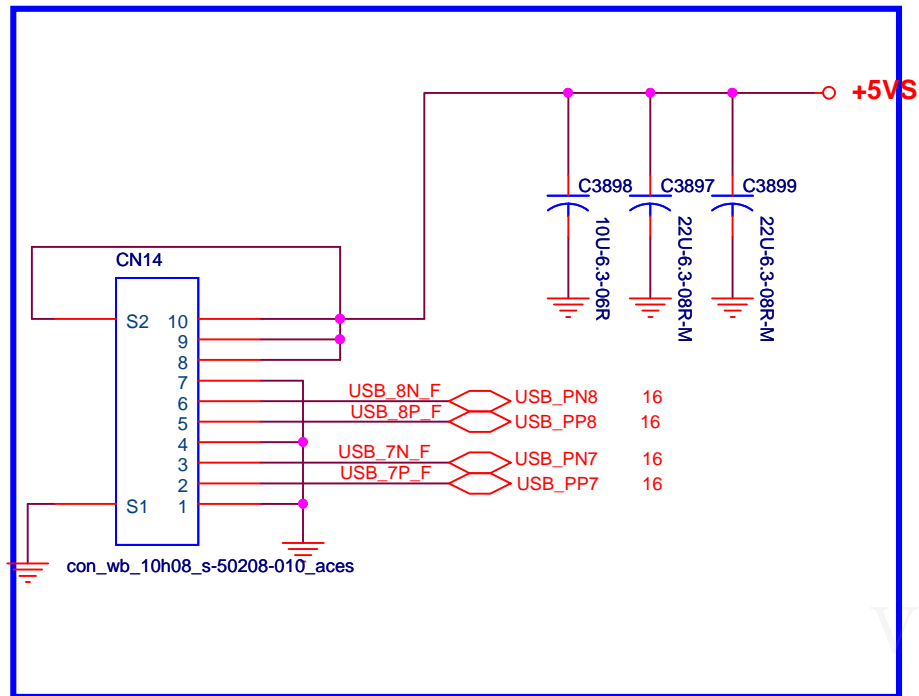
FAN CONTROLLER 0

FAN CONTROLLER 1

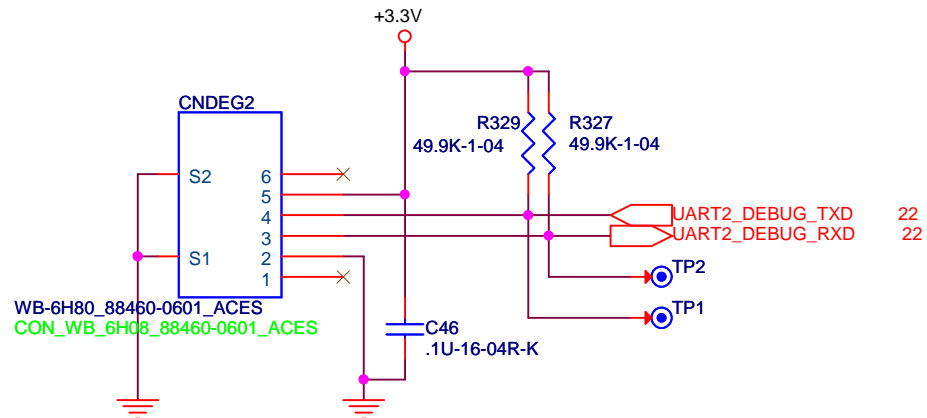


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Title	EXT_AUDIO/EXT_USB/FAN
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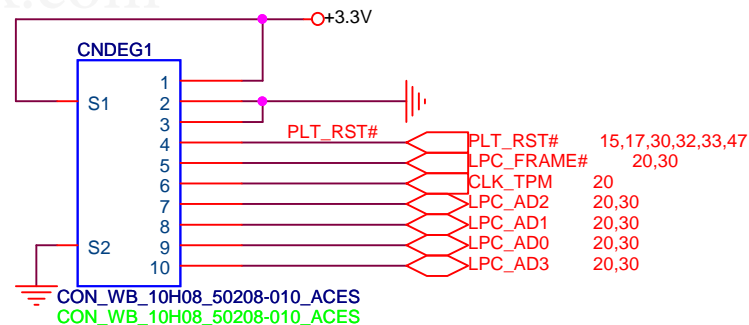
EXT USB2.0 DB



UART debug port

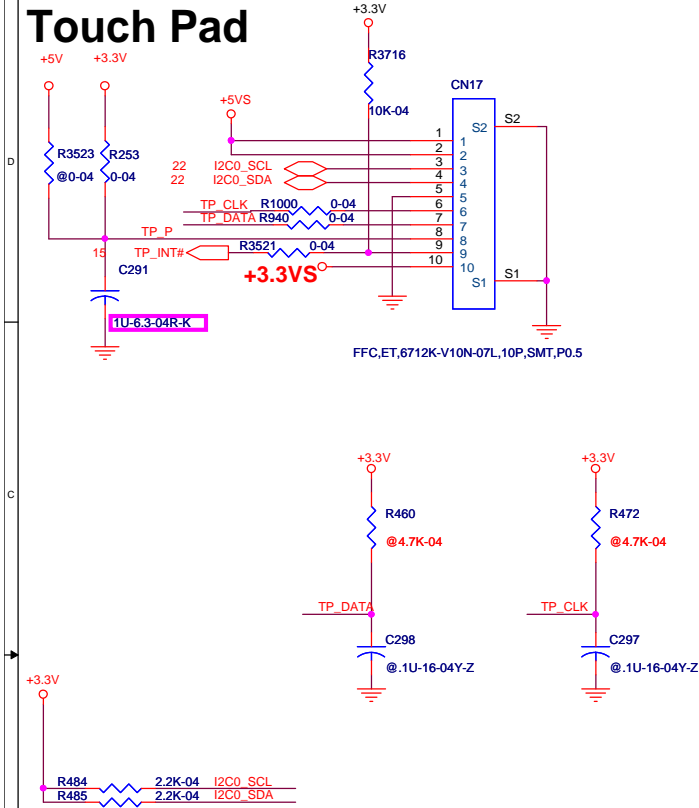


LPC debug port

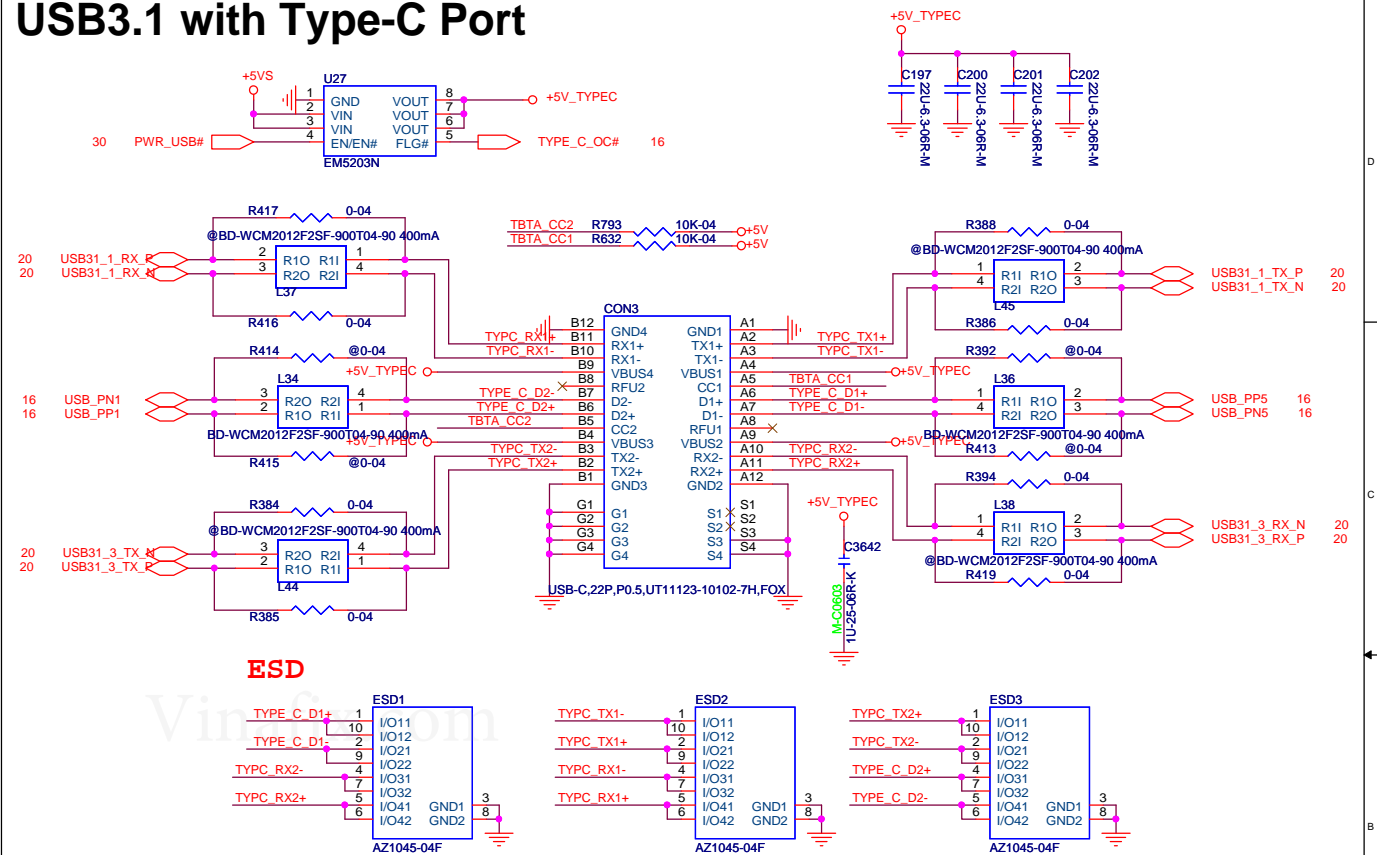


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Title EXT USB3.0	
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Touch Pad

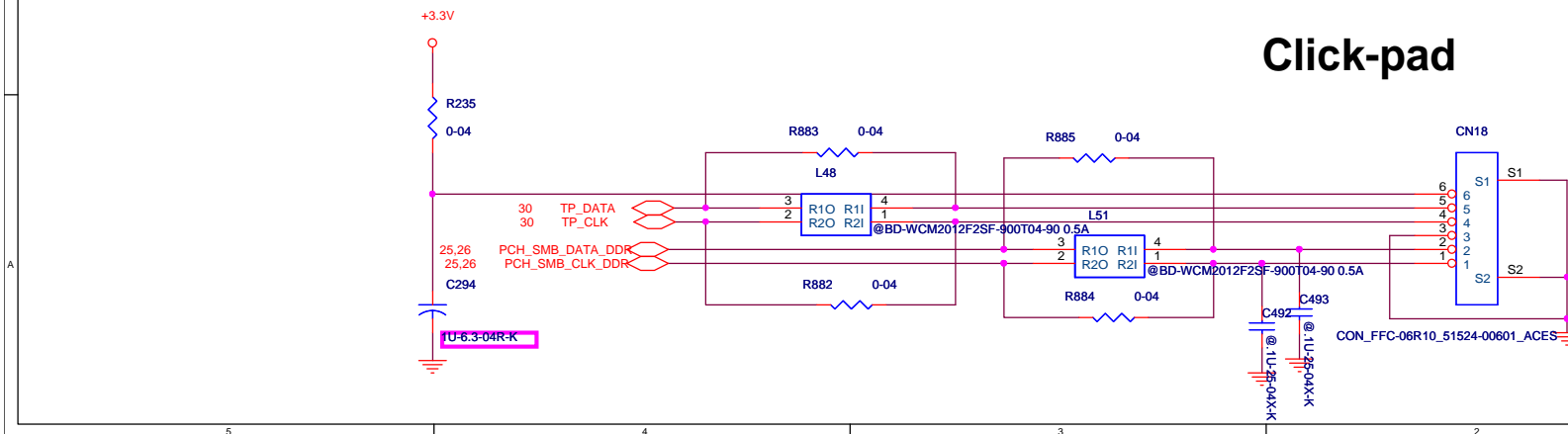


USB3.1 with Type-C Port



Click-pad

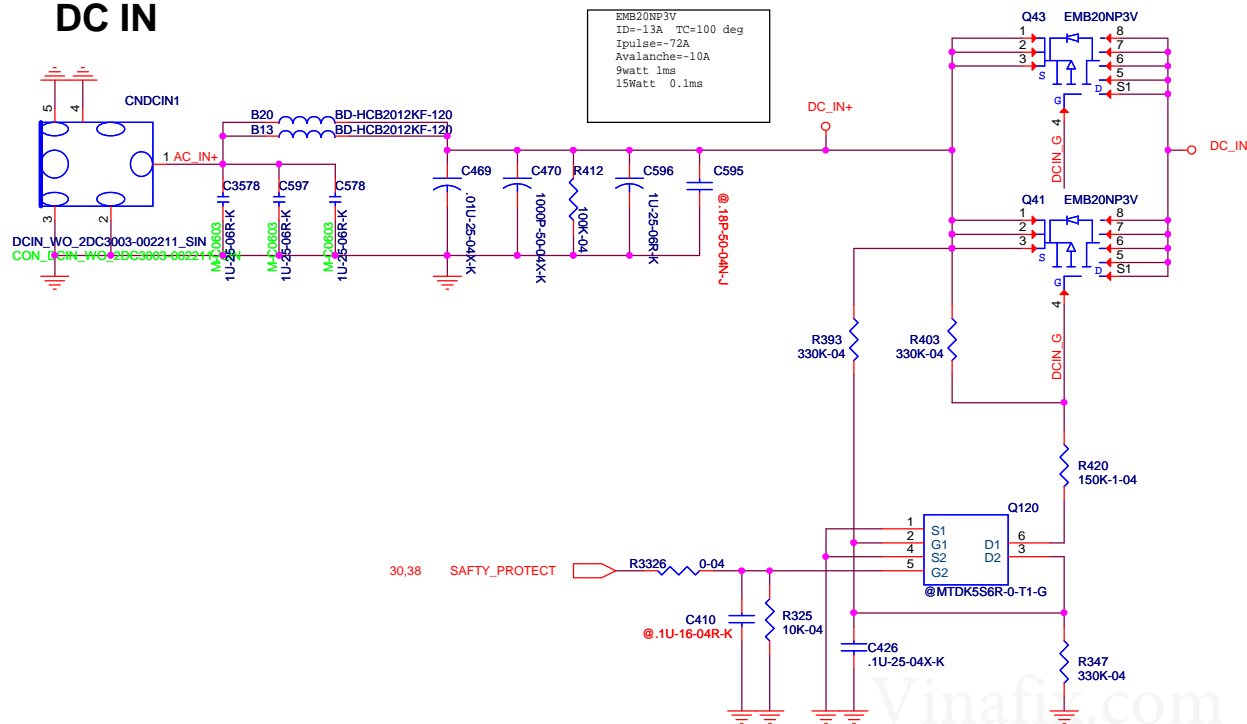
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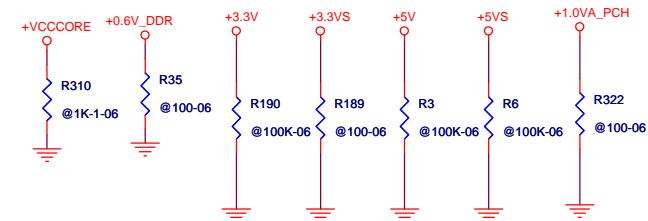
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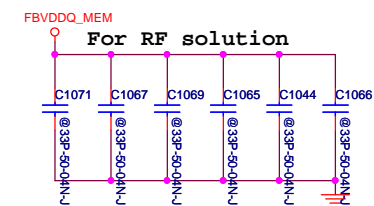
DC IN



Discharge Resistor

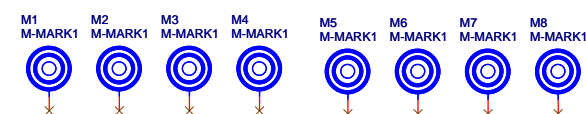
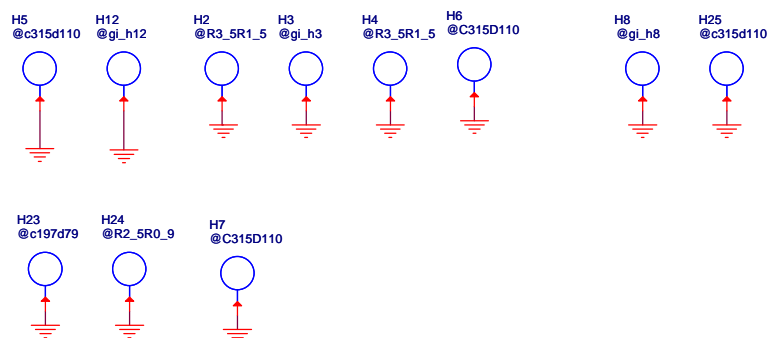


HIGH-SPEED CAP



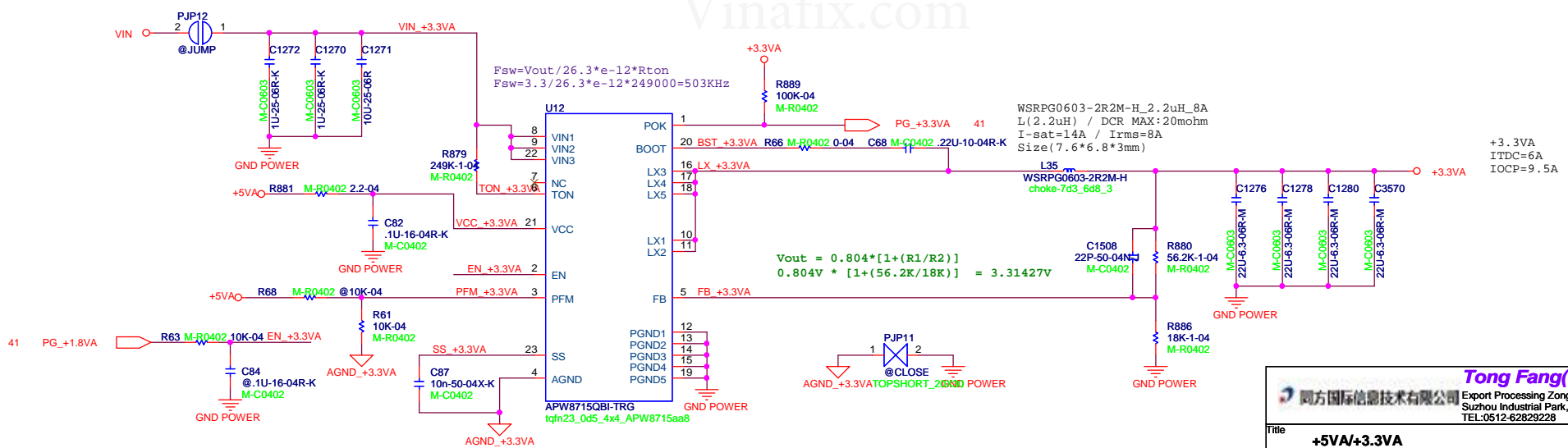
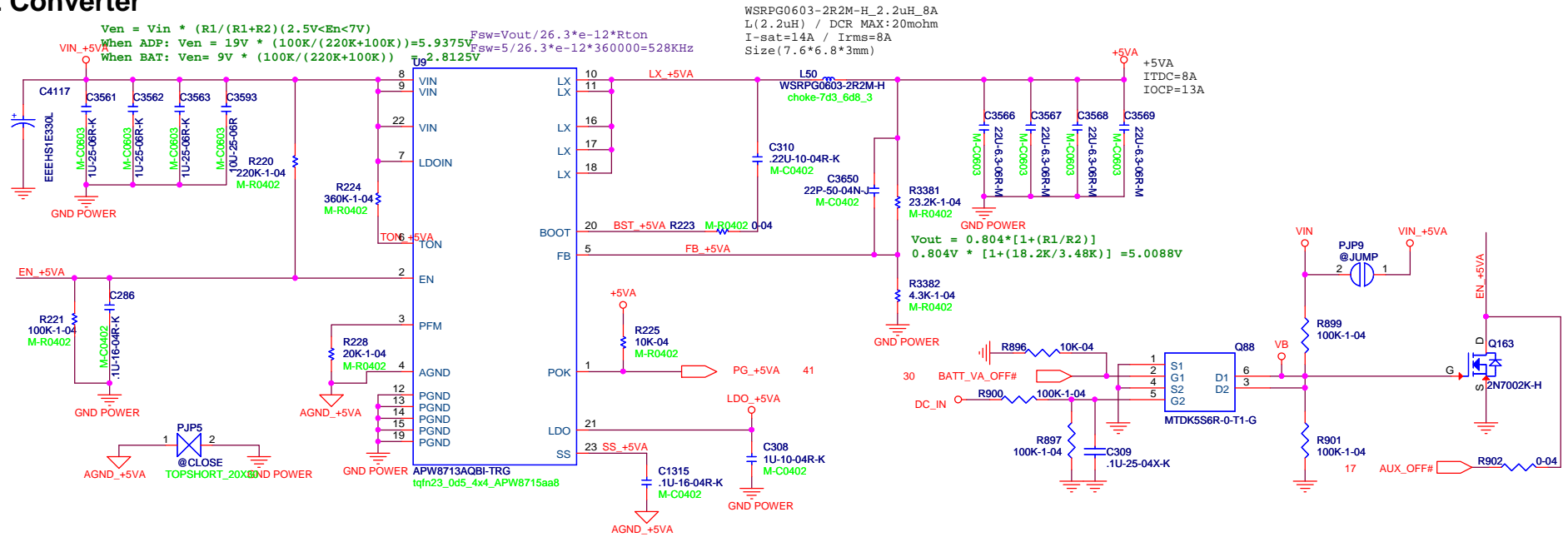
PCB HOLE

THERMAL HOLE



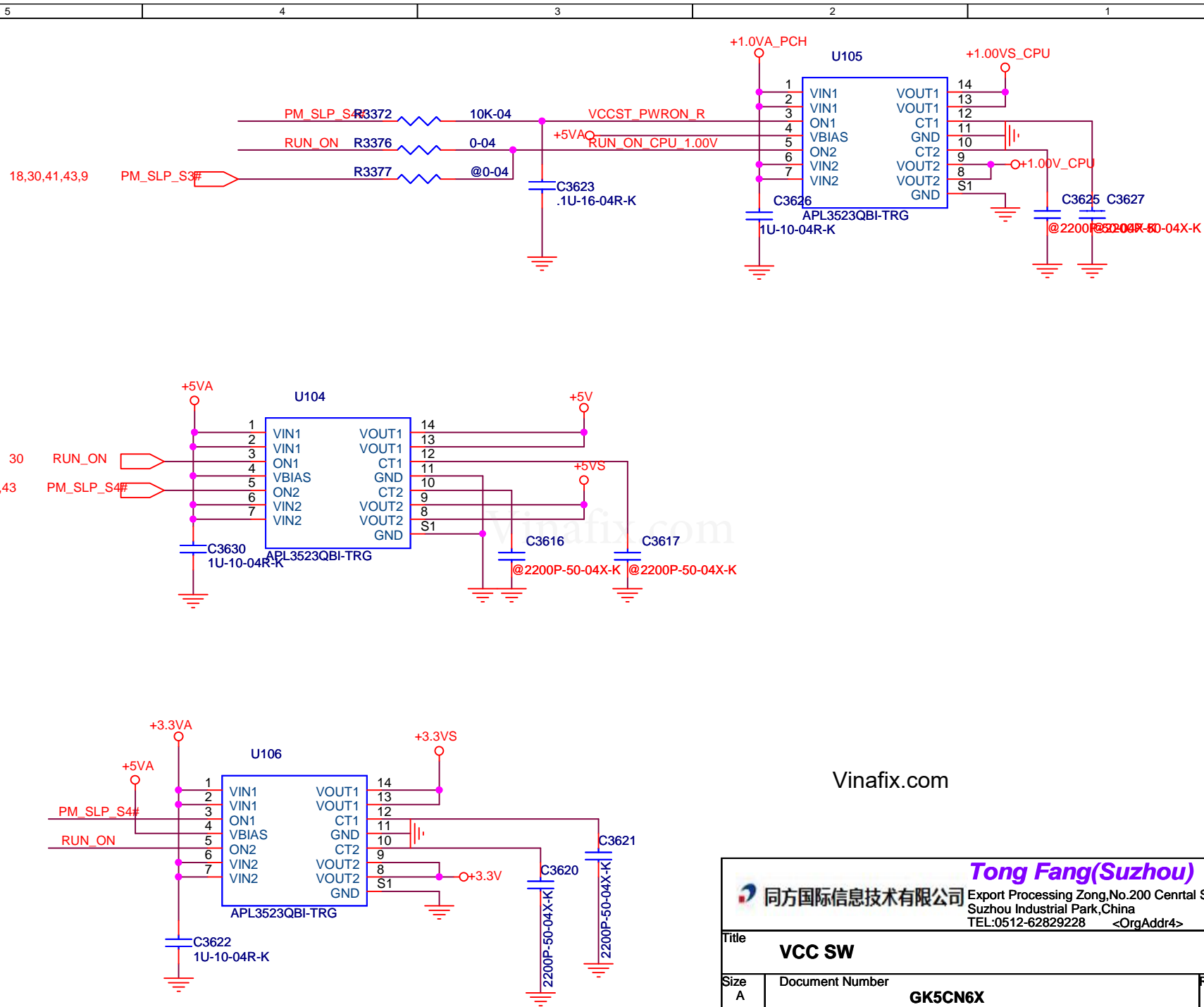
Tong Fang(Suzhou) 同方国际信息技术有限公司 Export Processing Zone, No.200 Central SuHong Road Suzhou Industrial Park, China TEL:0512-62829228 <OrgAddr4>	
Title	DC IN/TPM/D-Resis/HOLE
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5VAL Converter



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Title				
+5VA+3.3VA				
Size B	Document Number			Rev V A
GK5CN6X				
Date:	Wednesday, October 25, 2017	Sheet	40 of 72	

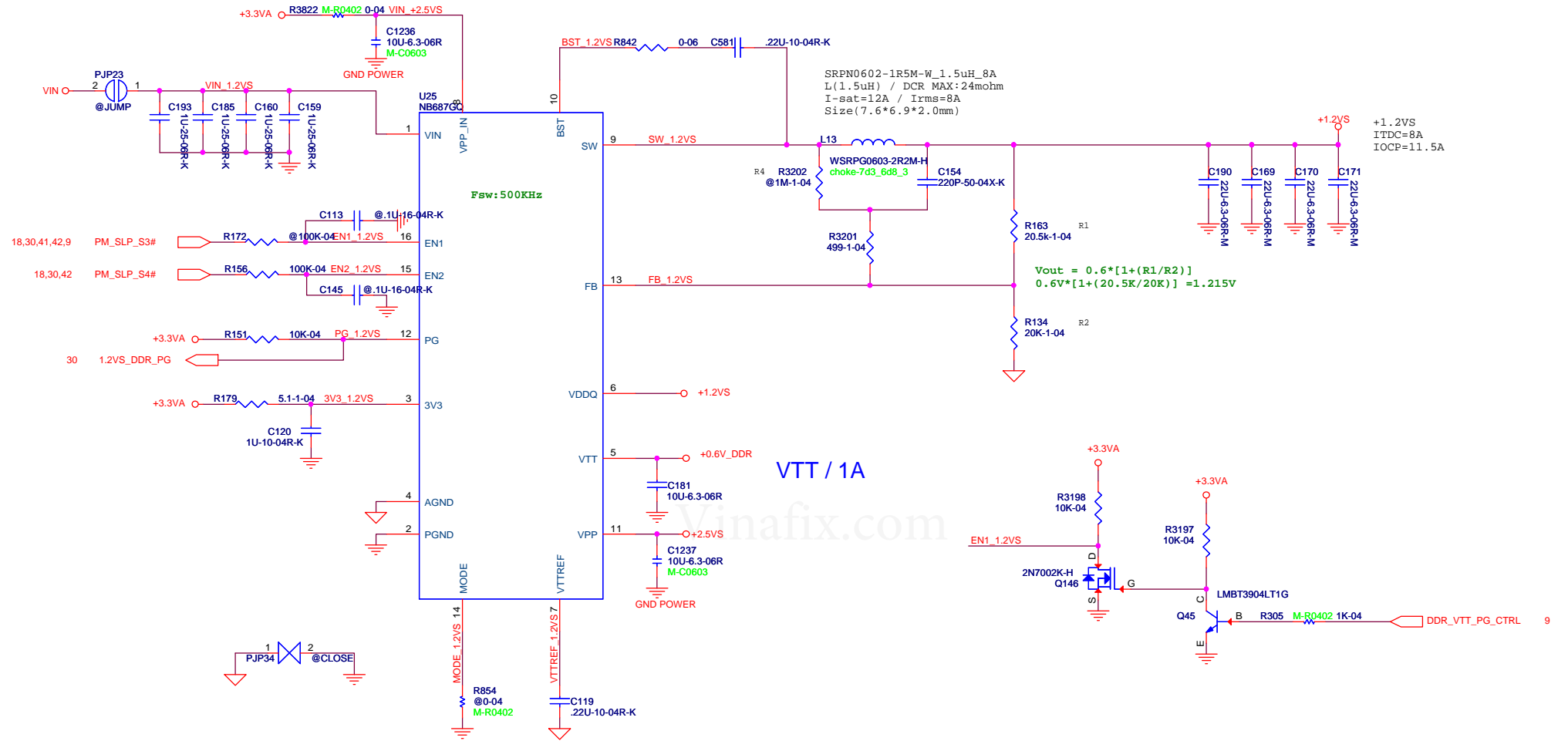
[illegible][illegible]



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Title VCC SW	
Size A	Document Number GK5CN6X
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1.2VS/VT/2.5VS

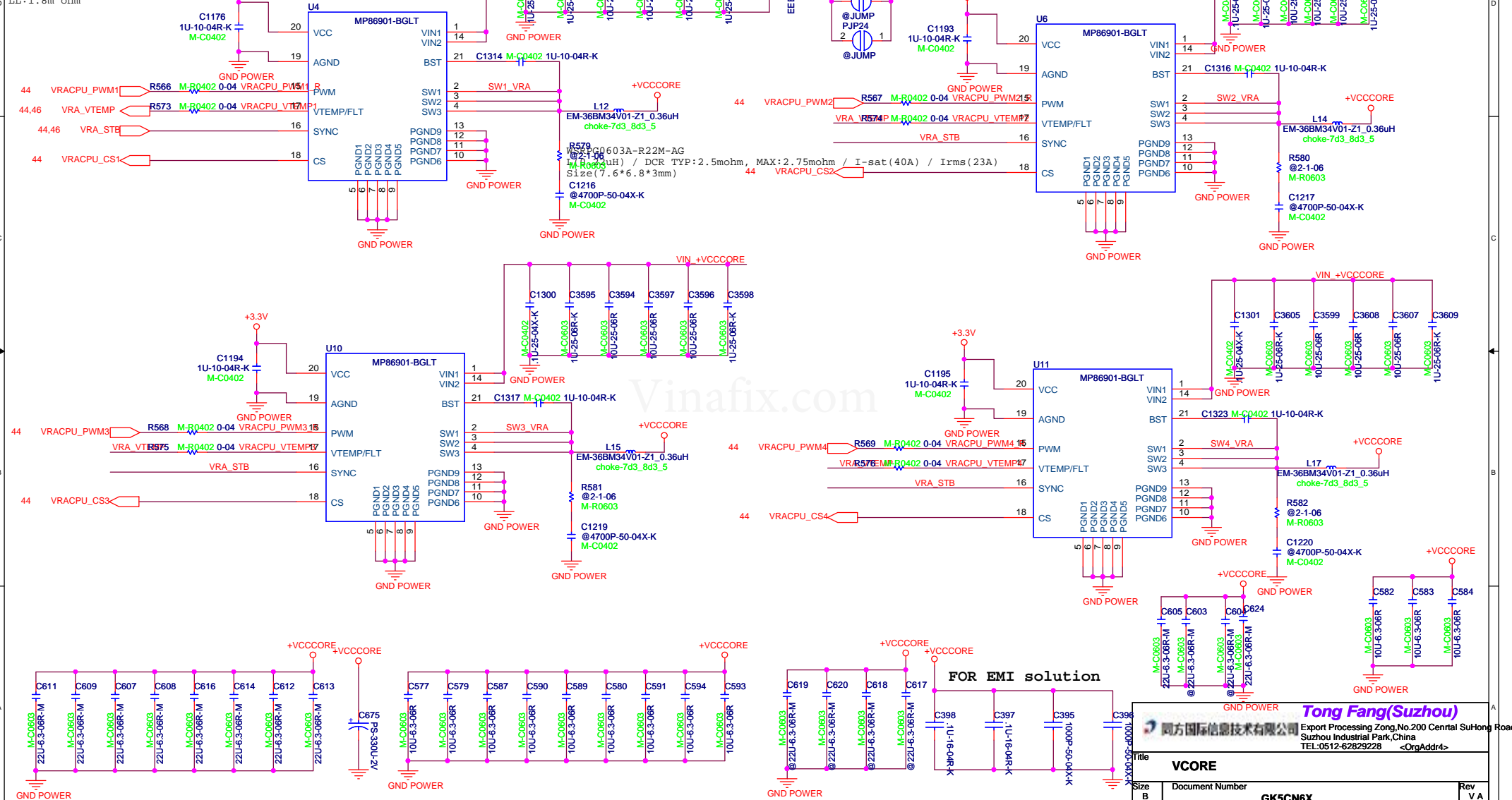


Tong Fang(Suzhou) 同方国际信息技术有限公司 Export Processing Zone, No.200 Central SuHong Road Suzhou Industrial Park, China TEL:0512-62829228 <OrgAddr4>		
Title: +1.2VS+2.5VS		
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VCCORE

VCORE:0.55~1.52V Vboot:0V
Core: Iccmax=68A
Core: TDC=50A
FSW:600KHz
di(IccMax transient):58A
dt(Slew time for the di step):65ns
IMVP8 Domain Address HEX:00h
LL:1.8m ohm

High side
Rds(on) TYP:10.5mohm
Low side
Rds(on) TYP:3.7mohm
MP86910B
ITDC:20A
ICCMAX:35A



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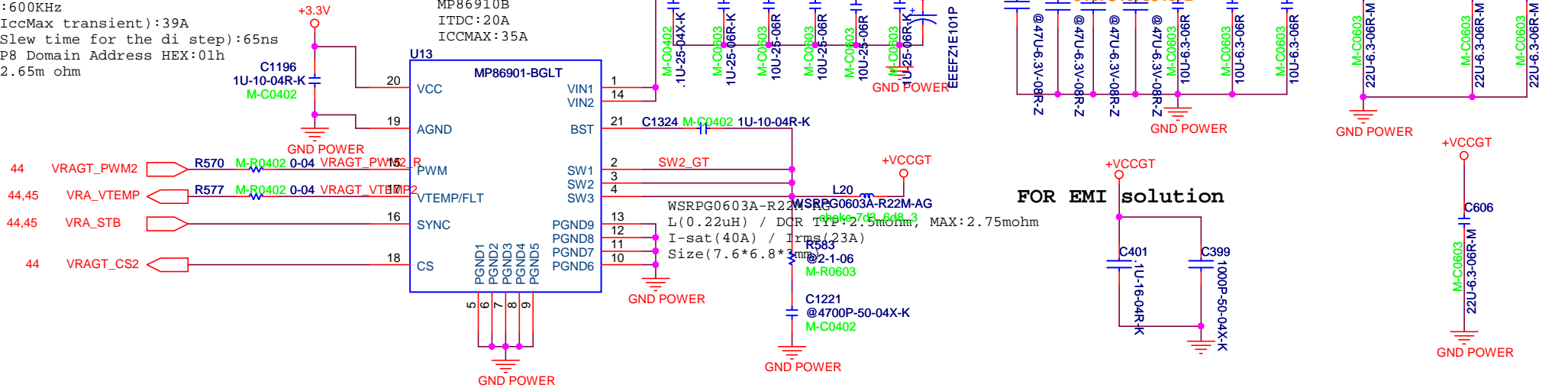
Title		VCCORE	
Size	Document Number	Rev	
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```

VGT:0.55V~1.52V Vboot:0V
GT: Iccmax=55A
GT: TDC=25A
FSW:600KHz
di(IccMax transient):39A
dt(Slew time for the di :
IMVP8 Domain Address HEX
LL:2.65m ohm

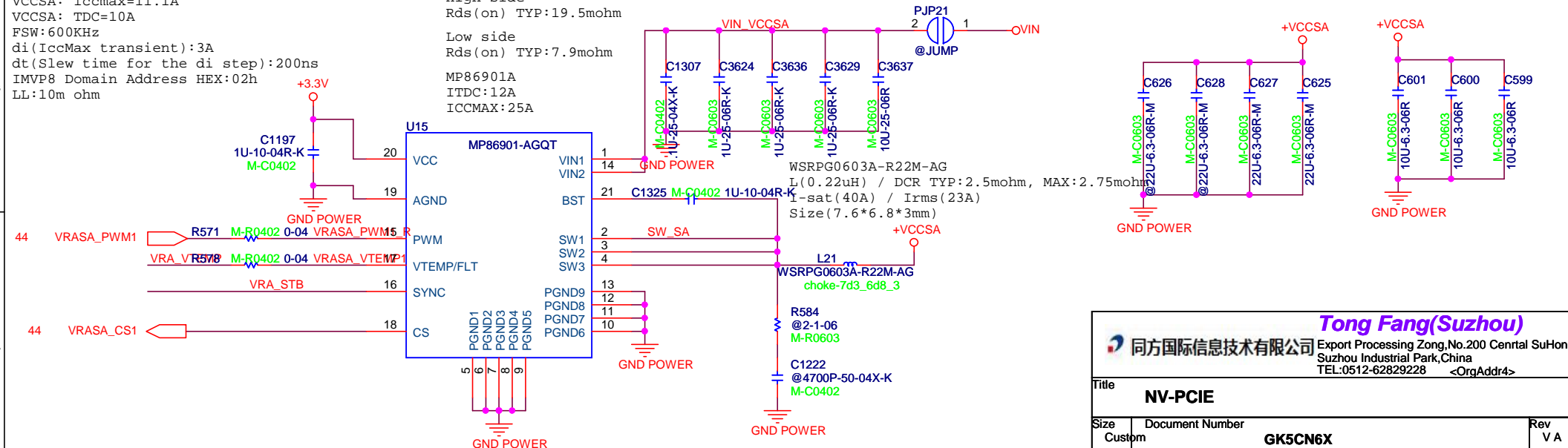
```

High side
Rds(on) TYP:10.5mohm
Low side
Rds(on) TYP:3.7mohm
MP86910B
ITDC:20A
ICCMAX:35A

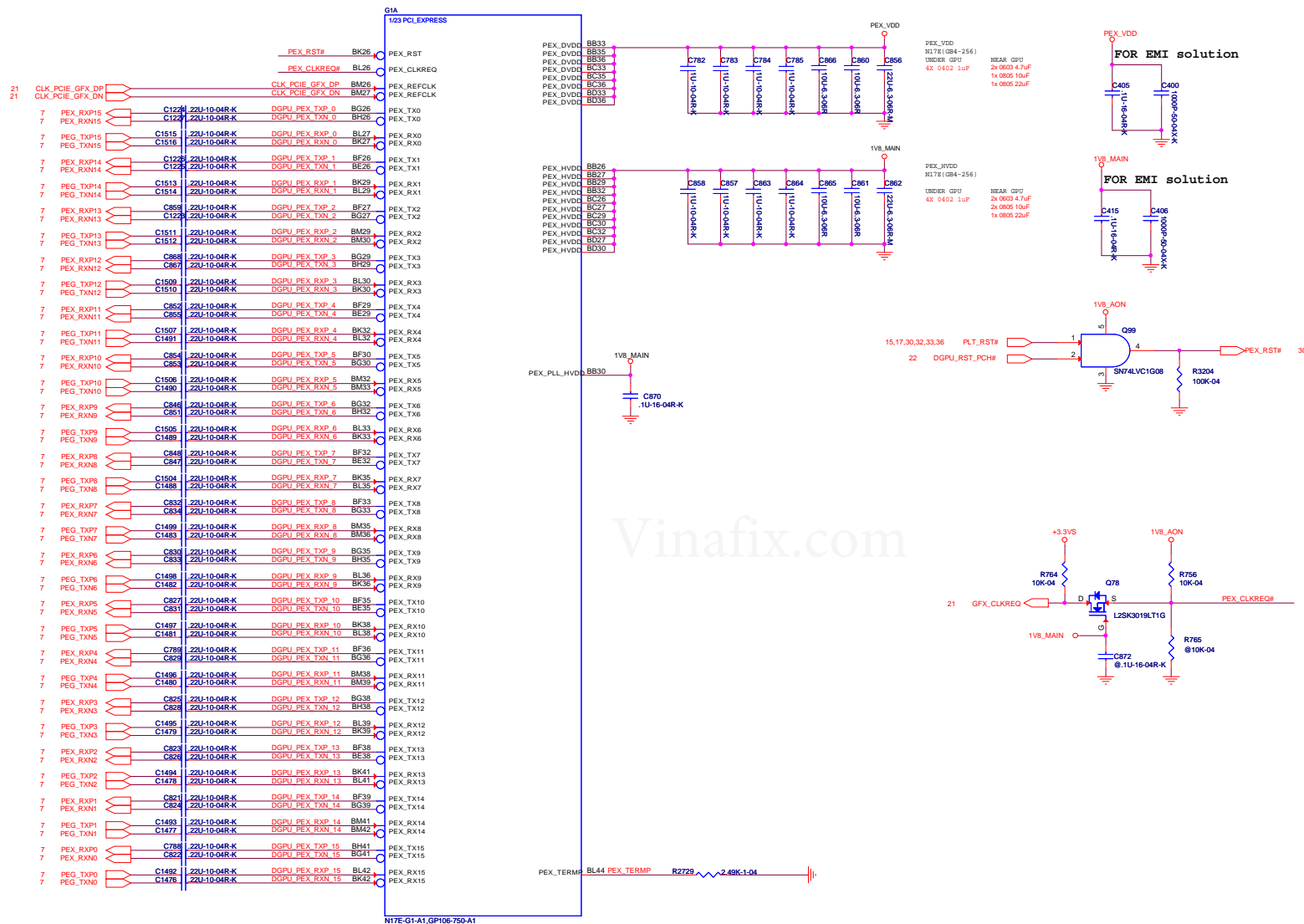


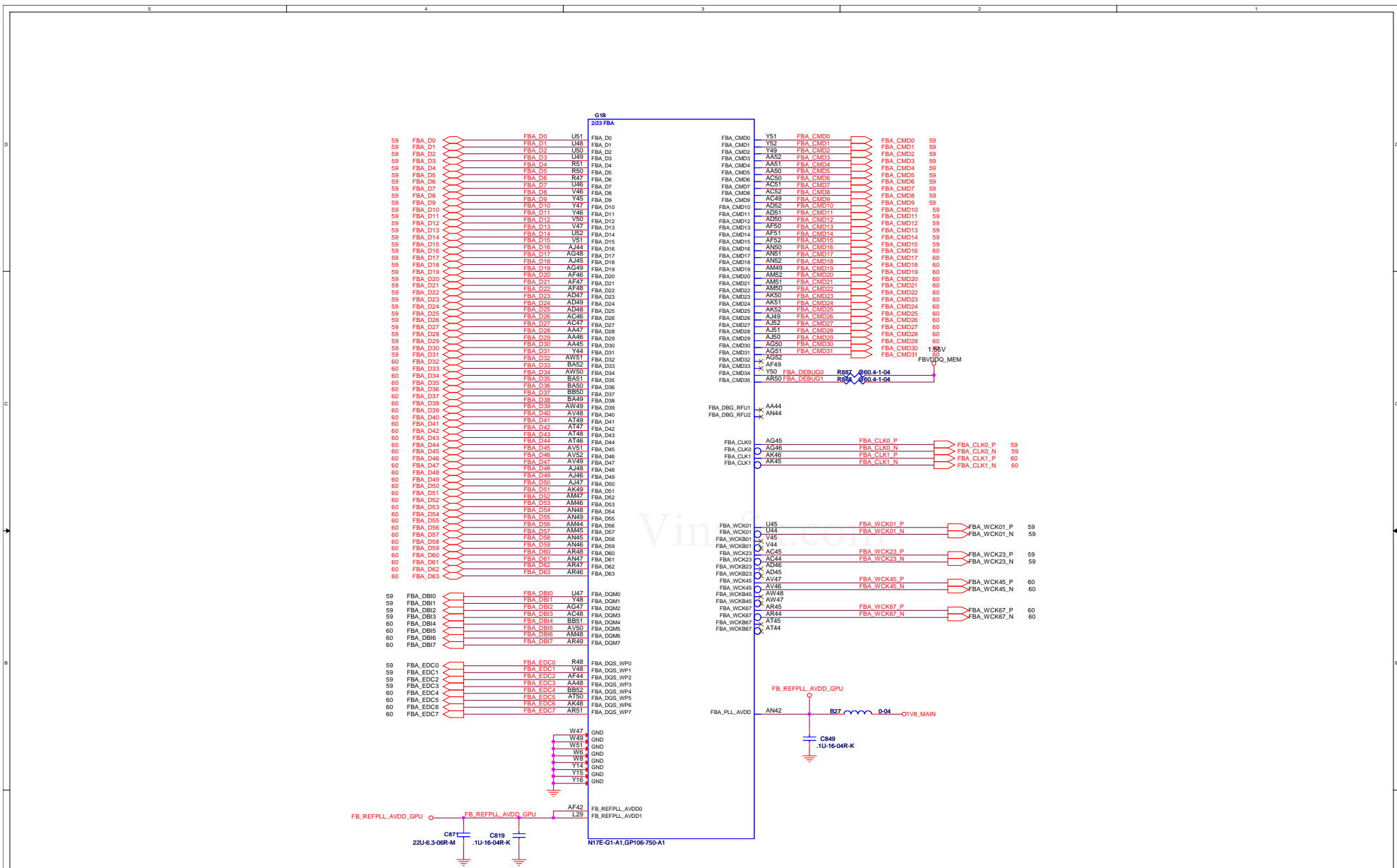
```
VCCSA:0.55~1.52V Vboot:1.05V
VCCSA: Iccmax=11.1A
VCCSA: TDC=10A
FSW:600KHz
di(IccMax transient):3A
dt(Slew time for the di step
IMVP8 Domain Address HEX:02h
LL:10m ohm
```

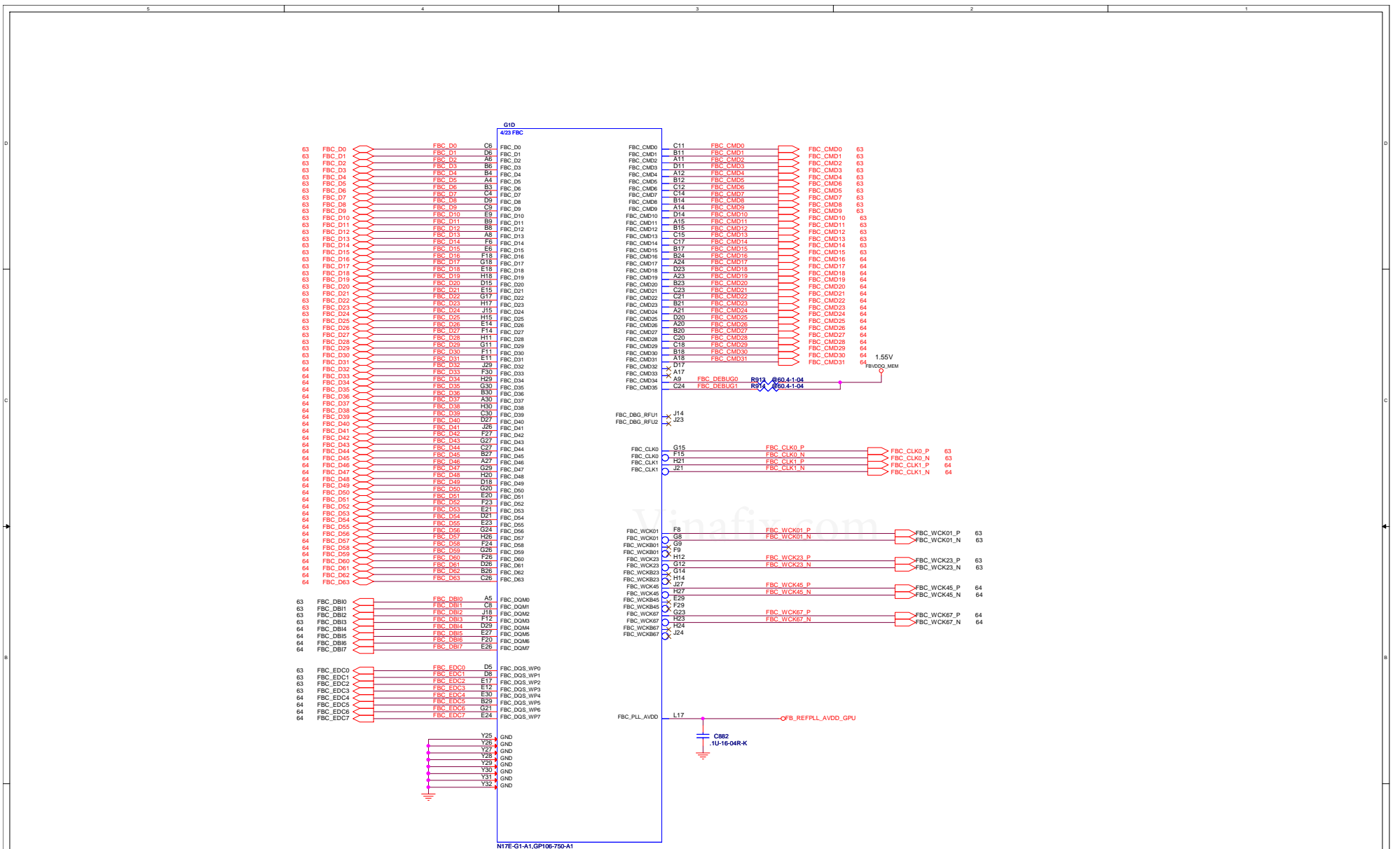
High side
Rds(on) TYP:19.5mohm
Low side
Rds(on) TYP:7.9mohm
MP86901A
ITDC:12A
ICCMAX:25A

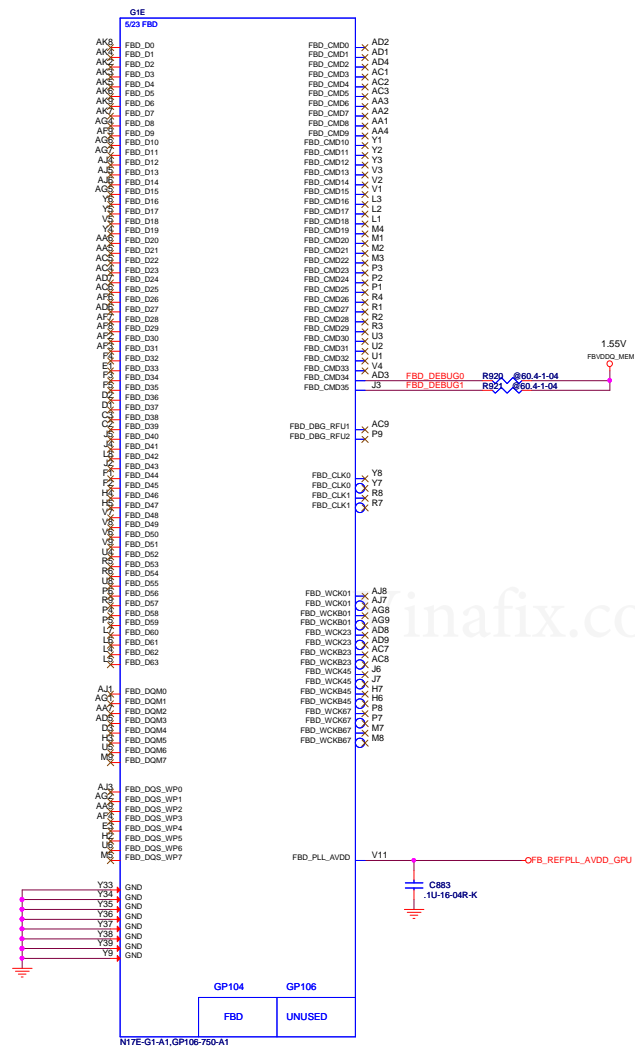


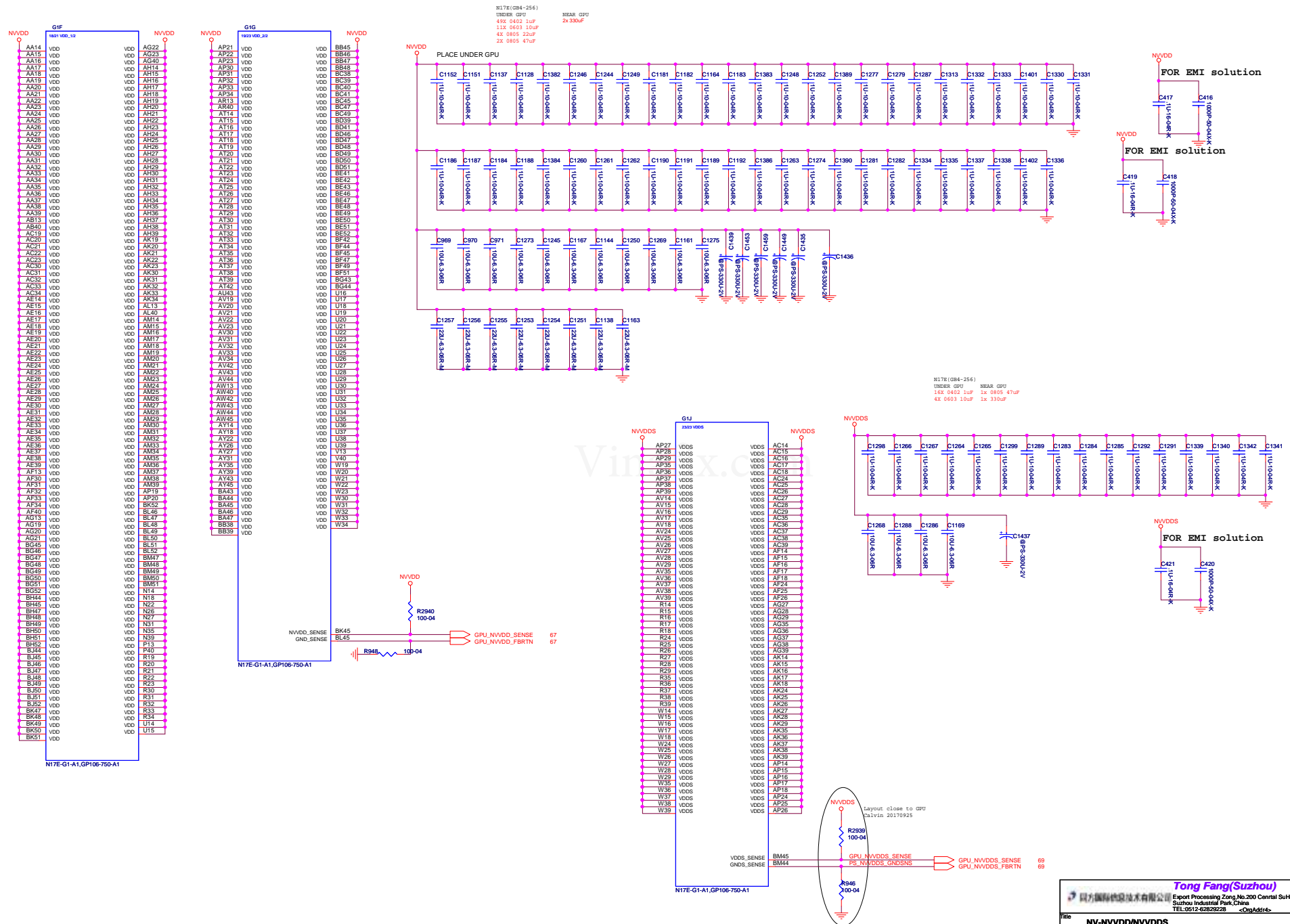
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Title NV-PCIE			
Size	Document Number	Rev	
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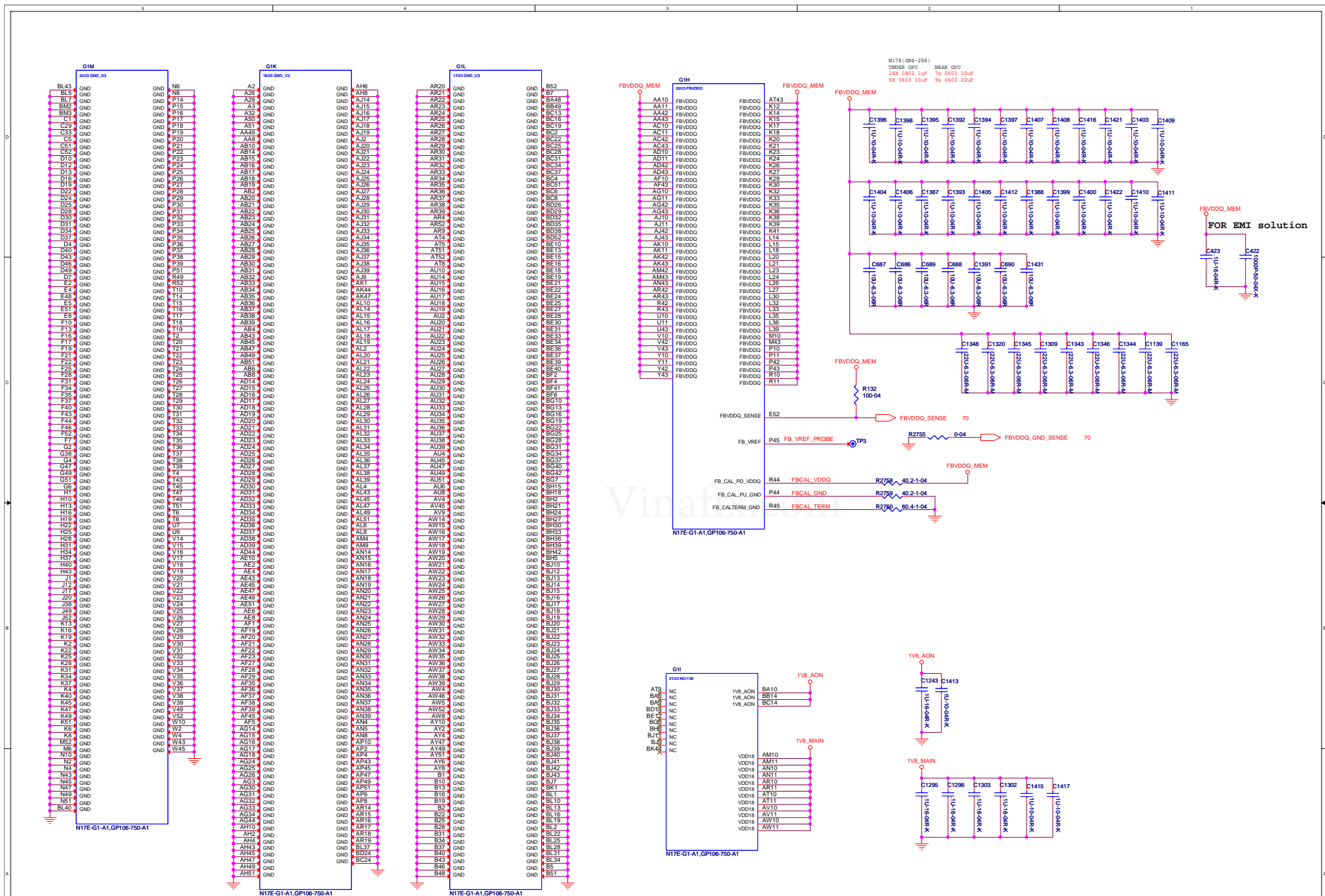




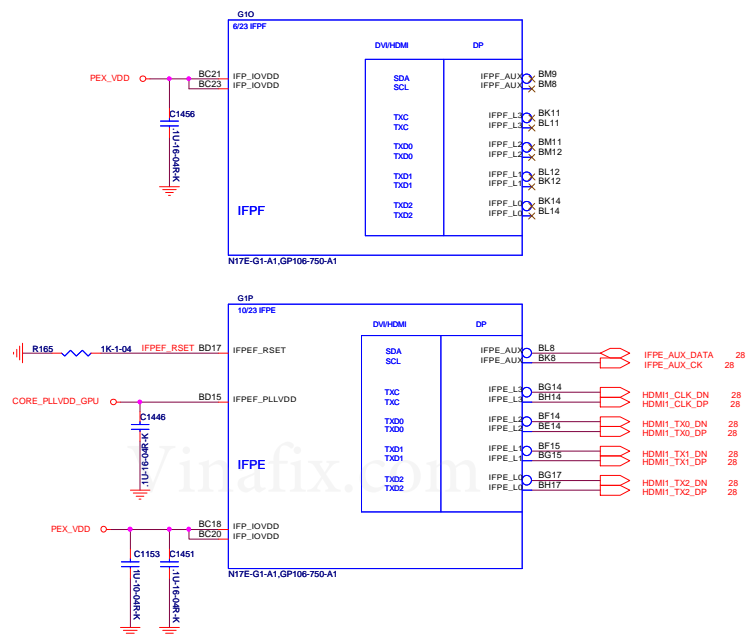
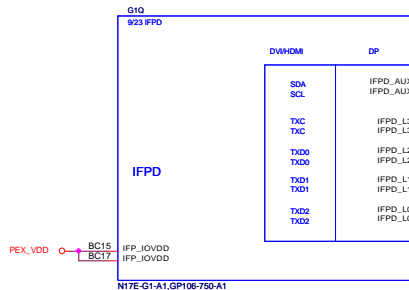
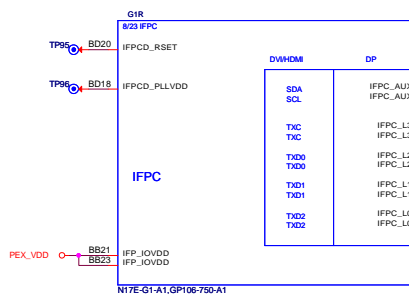
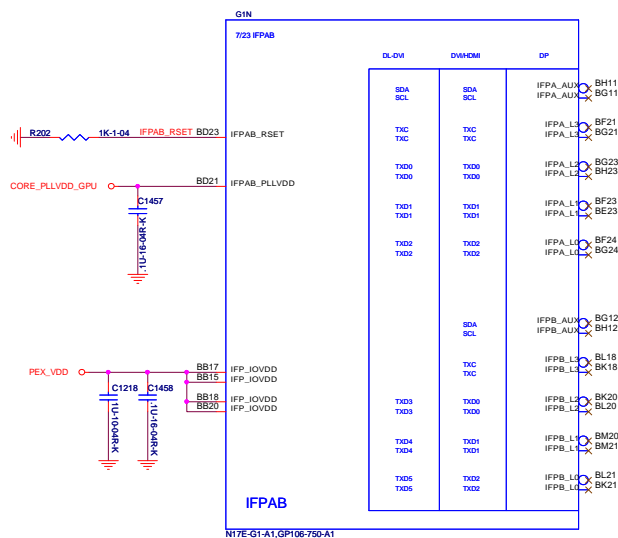




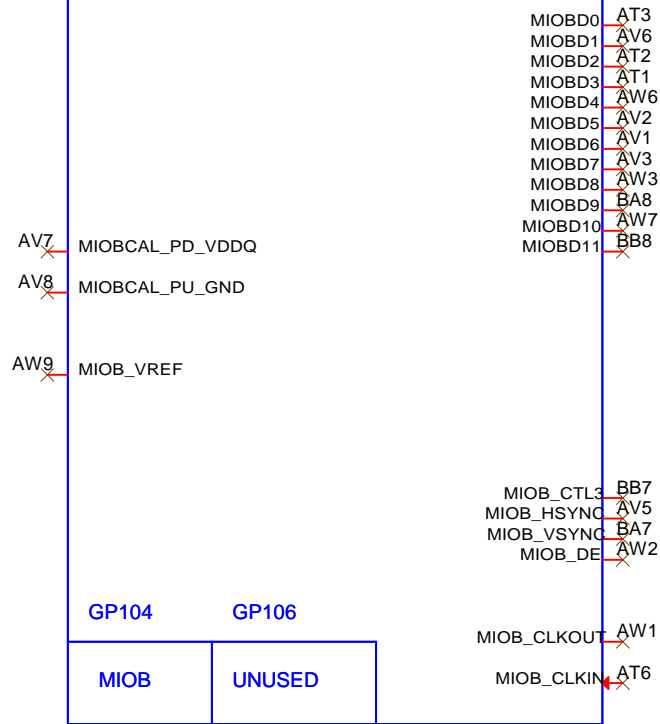




Hardware Design Guide Page282:
 For IFPA/B/C/D/E/F
 If an IFP link is not used, it should be NC
 including power rail and signal and references
 associated with LINKX

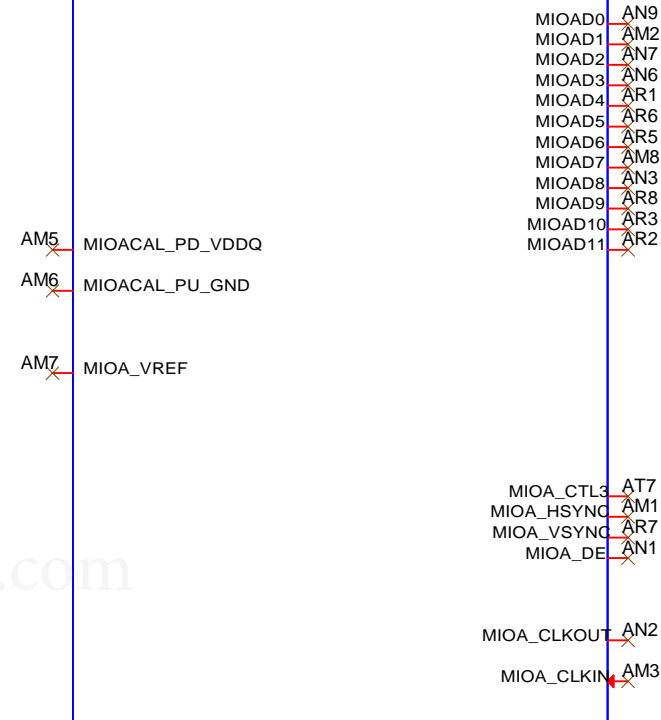


G1U
12/23 MIOB



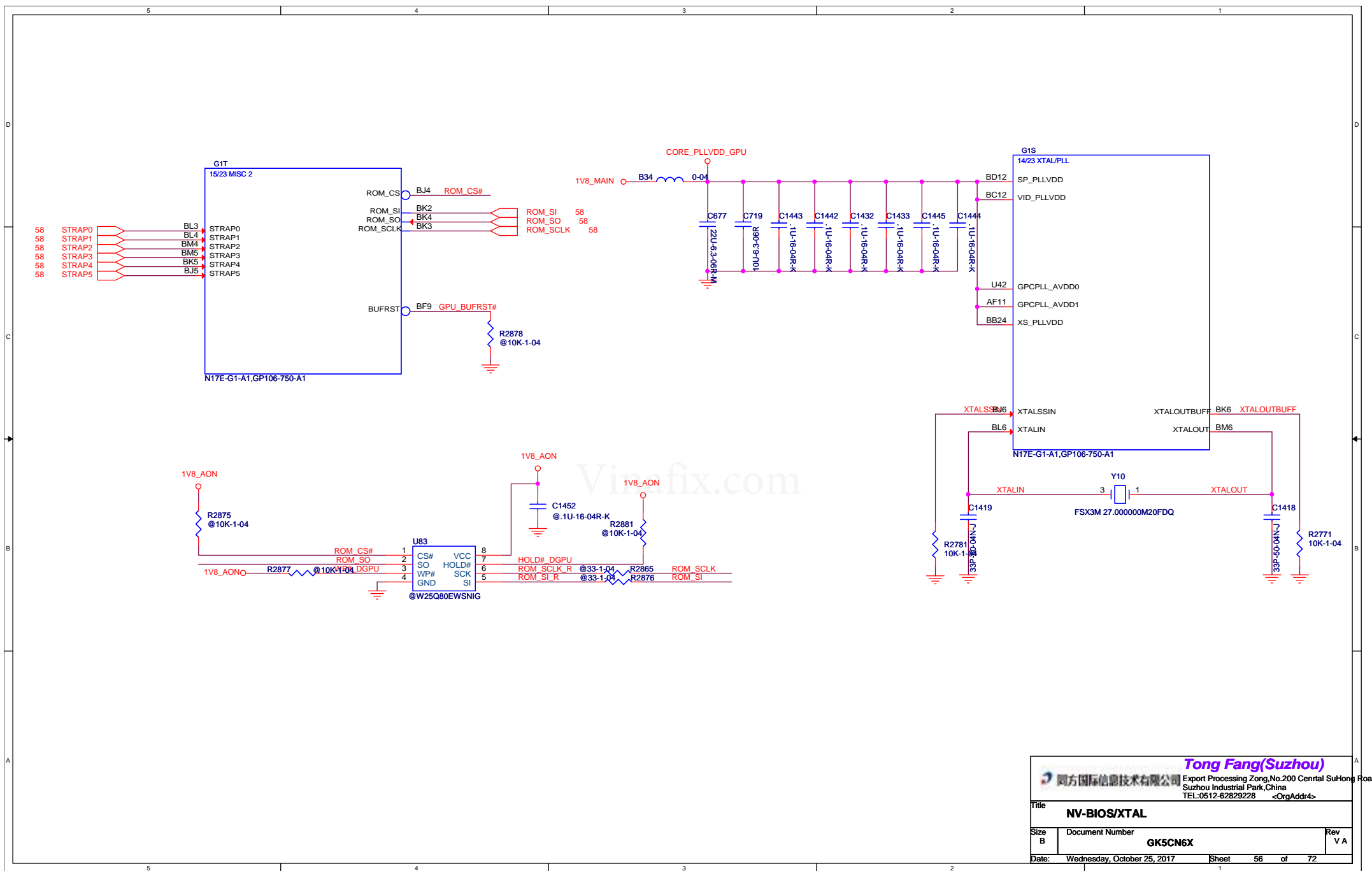
N17E-G1-A1,GP106-750-A1

G1V
11/23 MIOA



N17E-G1-A1,GP106-750-A1

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Size A	Document Number GK5CN6X		Rev V A
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Title		
NV-BIOS/XTAL		
Size	Document Number	Rev
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Voltage(V)			
LEVEL	Min	Normal	Max
H	1.5	1.8	1.854
M	0.5	0.9	1.3
L	0	0	0.3
Invalid	1.3V<pin voltage<1.5V 0.3V<pin voltage<0.5V		

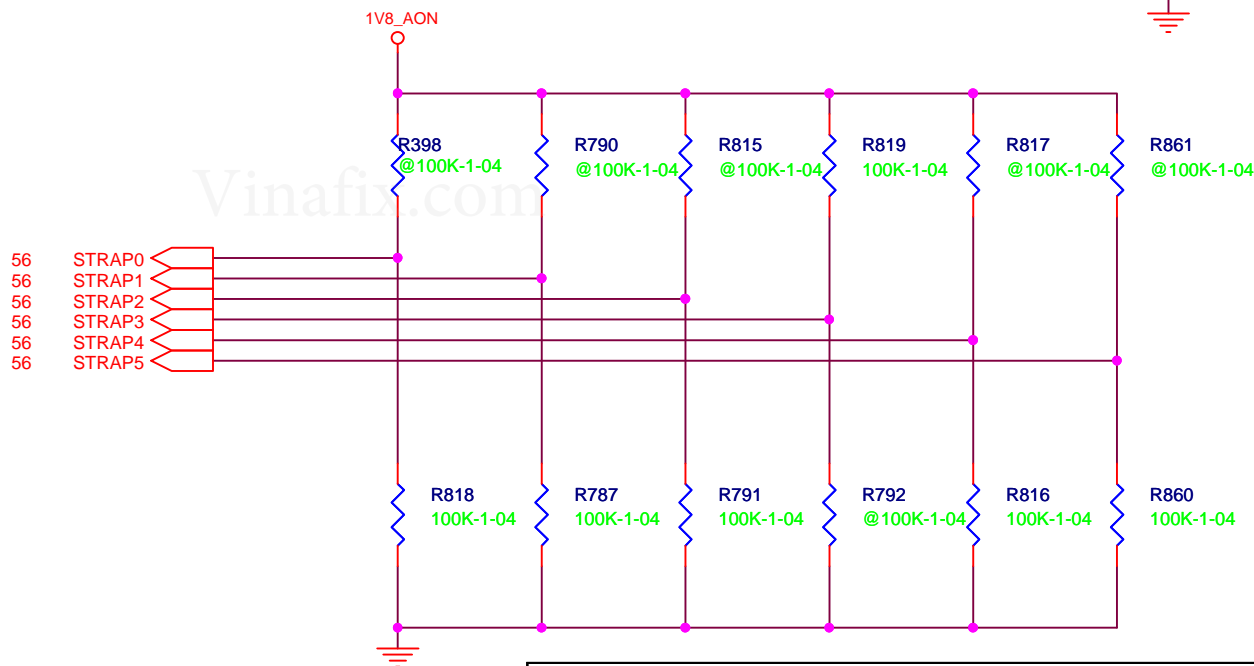
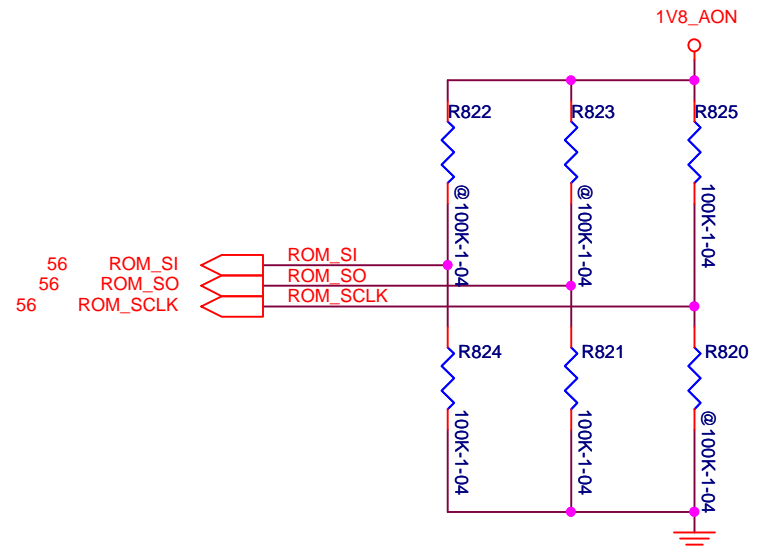
Based on RVL_07916_001_V10 JUNE 2017

GDDR5						
Density	Vendor	Part Number	Strap	Strap 2	Strap 1	Strap 0
8Gb	Samsung	K4G80325FB-HC25 B-die	0X0	L	L	L
8Gb	Micron	MT51J256M32HF-80:A A-die	0X1	L	L	H
8Gb	Hynix	H5GQ8H24MJR-R4C M-die	0X2	L	H	L
4Gb	Samsung	K4G41325FE-HC25 E-die	0X7	H	H	H
4Gb	Hynix	H5GQ4H24AJR-R4C A-die	0X6	H	H	L
4Gb	Micron					

TOTAL LINK	TOTAL EN AUDIO	ROW INDEX
4	4	15
3	3	14
2	2	12
3	2	12
4	3	13

ROW INDEX	STRAP PIN		
	ROM_S0	ROM_S1	ROM_SCLK
15	L	L	L
14	L	L	H
13	L	H	L
12	L	H	H
11	H	L	L
10	H	L	H
8	H	H	H
0	H	H	M

Display Link 15



Strap5,4,3 LLH

1:SMB_ALT_ADDR ENABLE
0:SMB_ALT_ADDR DISABLE

1:DEVID_SEL REBRAND
0:DEVID_SEL ORIGNAL

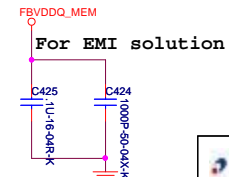
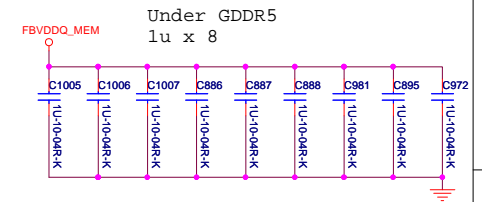
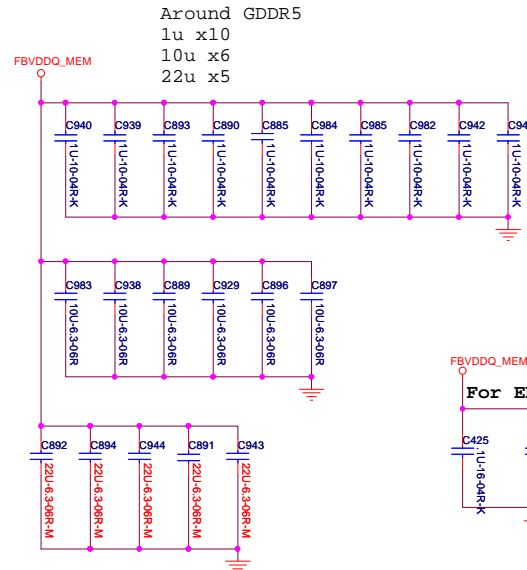
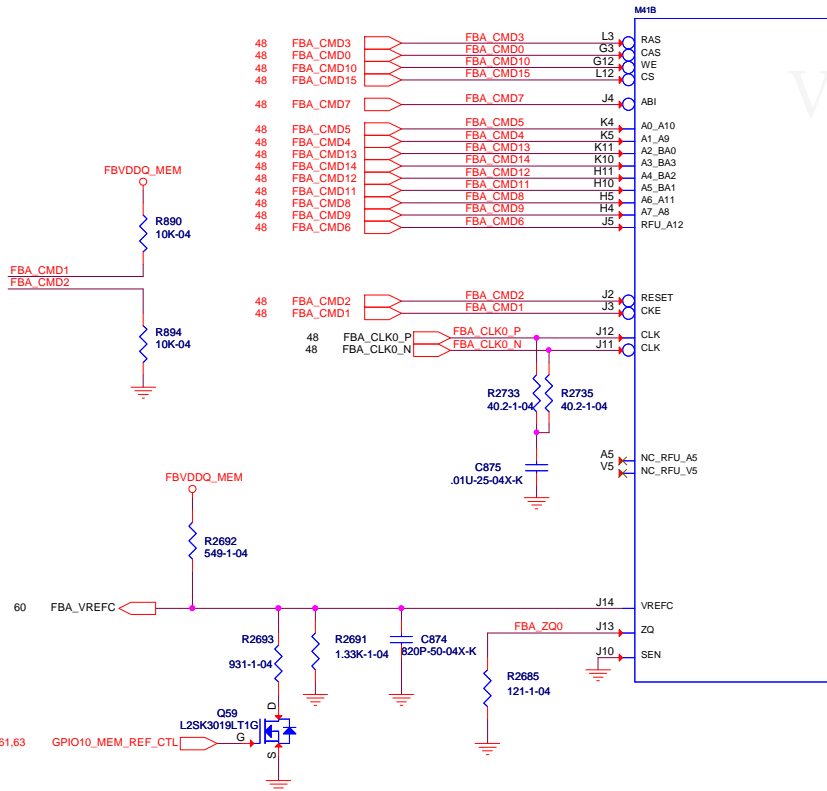
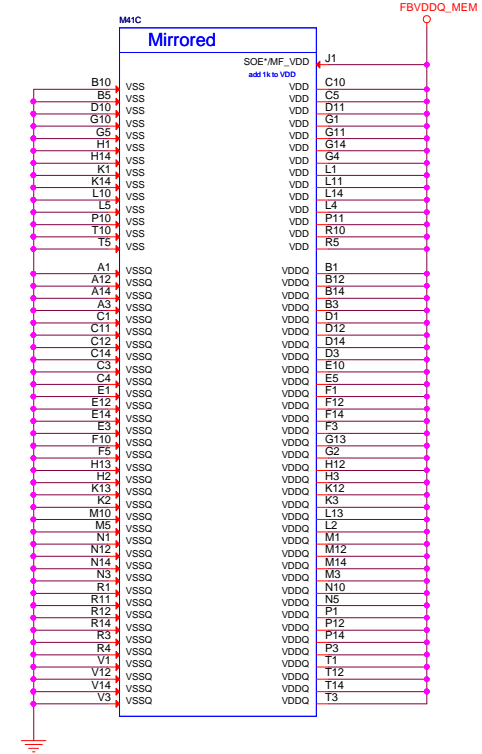
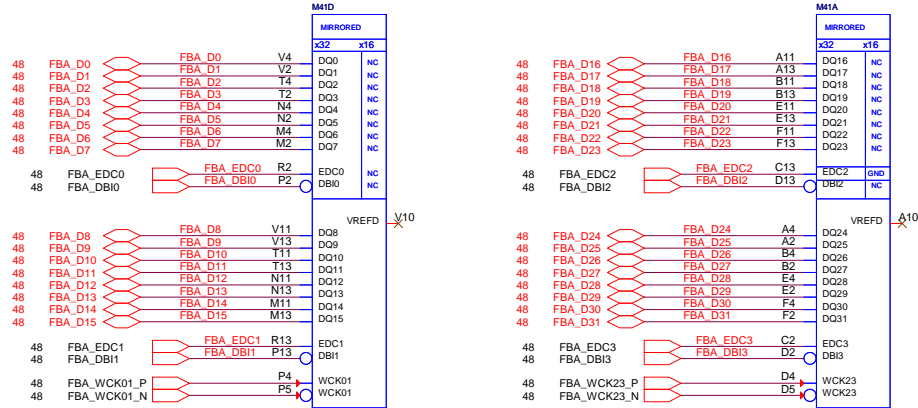
1:PCIE_CFG LOW POWER
0:PCIE_CFG HIGH POWER

1:VGA_DEVICE ENABLE
0:VGA_DEVICE DISABLE

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Title STRAP			
Size A	Document Number GK5CN6X		Rev V A
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MEM_FBA[31_0]

Maximum VRAM case Temp is 85 celsius degree



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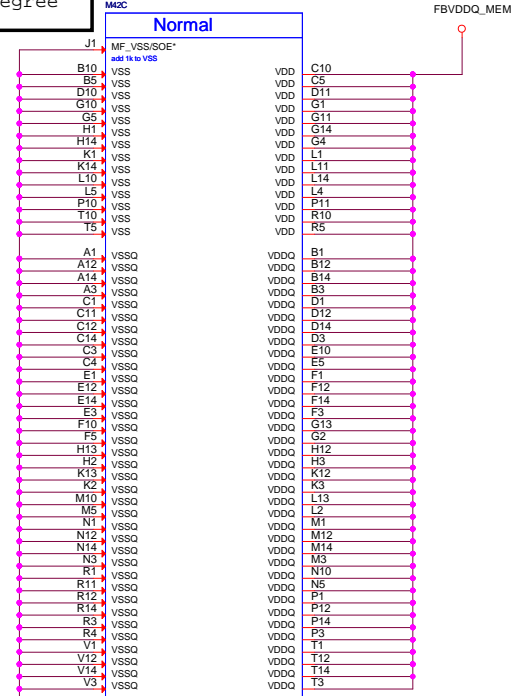
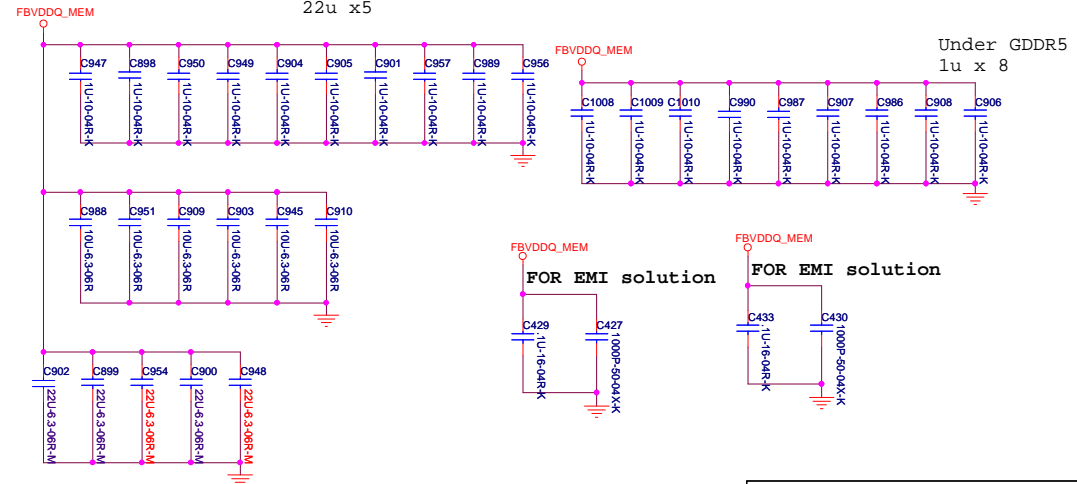
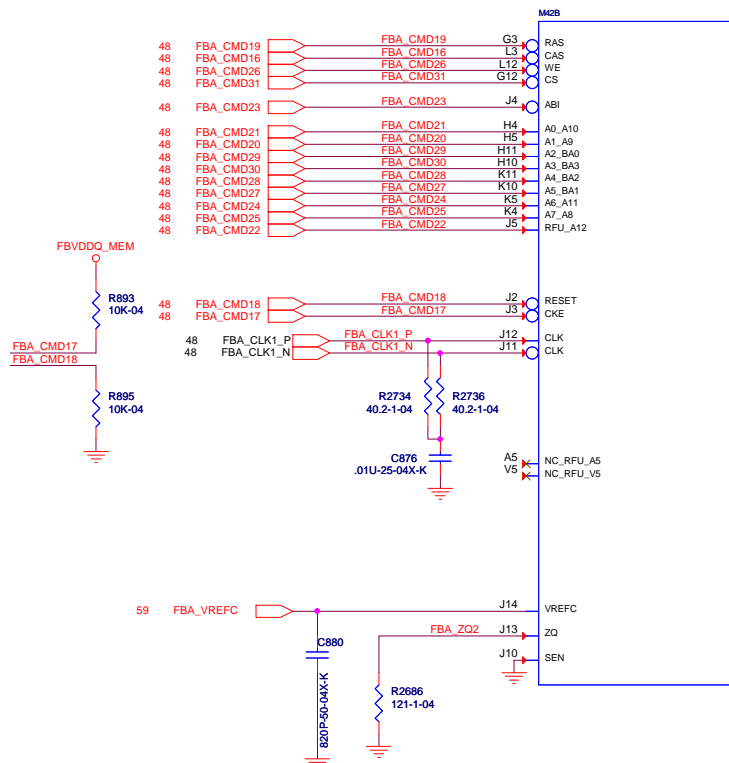
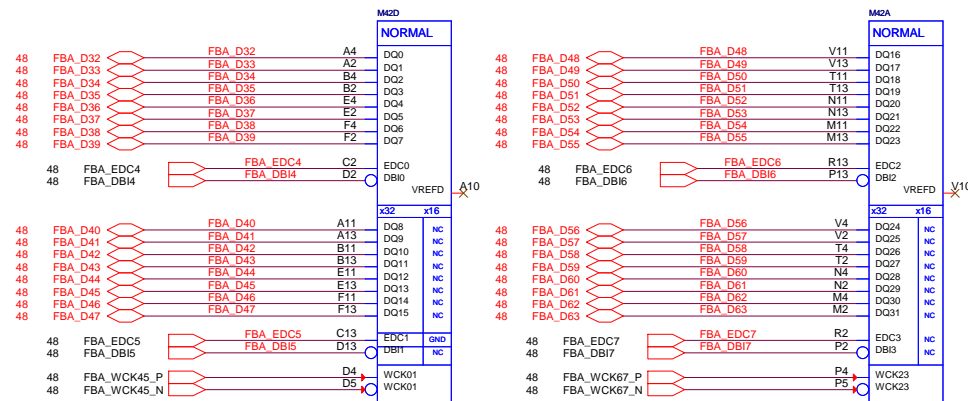
Frame Buffer A0-VRAM

Size: Custom Document Number: **GK5CN6X** Rev: V A

Date: Wednesday, October 25, 2017 Sheet: 59 of 72

MEM_FBA[63_32]

Maximum VRAM case Temp is 85 celcibus degree



Around GDDR5
1u x10
10u x6
22u x5

Under GDDR5
1u x 8

FOR EMI solution

FOR EMI solution

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Title	
Frame Buffer A1-VRAM	
Size	Document Number
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[illegible]

MEM_FBB[63_32]

Maximum VRAM case Temp is 85 celcius degree

M44D NORMAL

M44A NORMAL

M44B

M44C Normal

FBVDDQ_MEM

FBVDDQ_MEM

Under GDDR5
1u x 8

Around GDDR5
1u x10
10u x6
22u x5

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Title
Frame Buffer B1-VRAM

Size
Custom

Document Number
GK5CN6X

Rev
V A

Date
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MEM_FBB[63_32]

Maximum VRAM case Temp is 85 celcius degree

M44D NORMAL

M44A NORMAL

M44B

M44C Normal

FBVDDQ_MEM

FBVDDQ_MEM

Under GDDR5
1u x 8

Around GDDR5
1u x10
10u x6
22u x5

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Title
Frame Buffer B1-VRAM

Size
Custom

Document Number
GK5CN6X

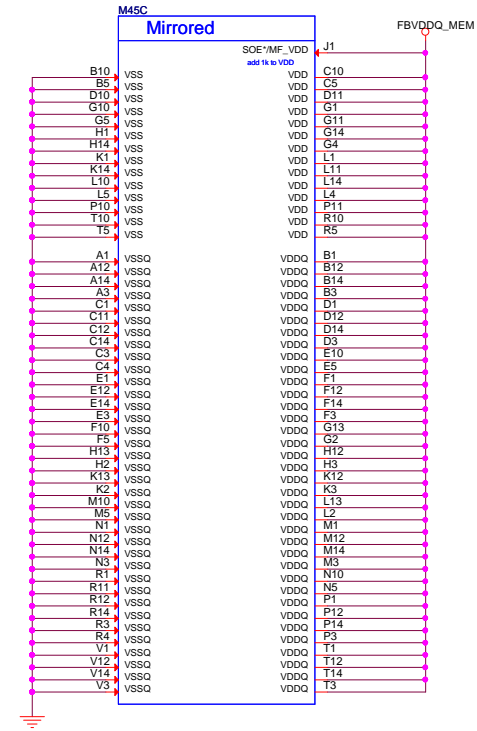
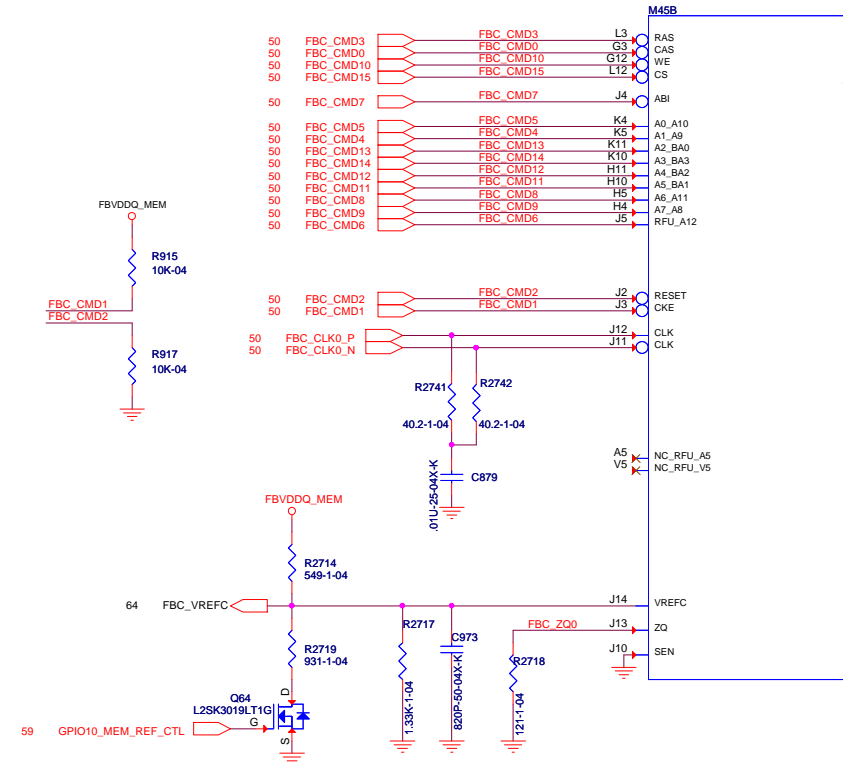
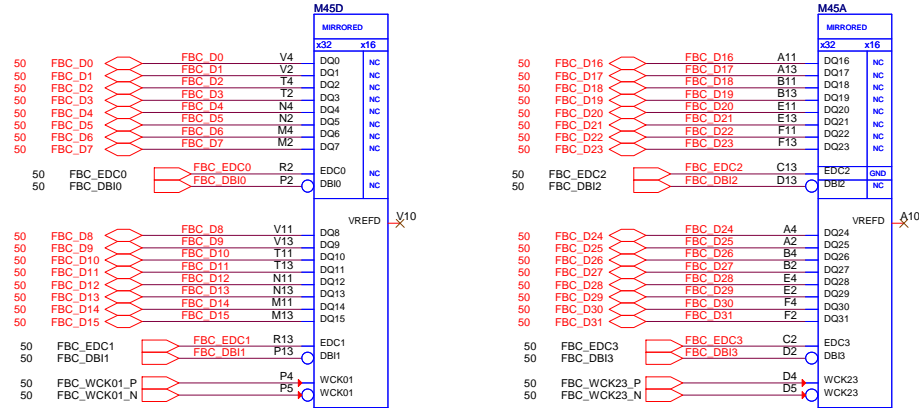
Rev
V A

Date
Wednesday, October 25, 2017

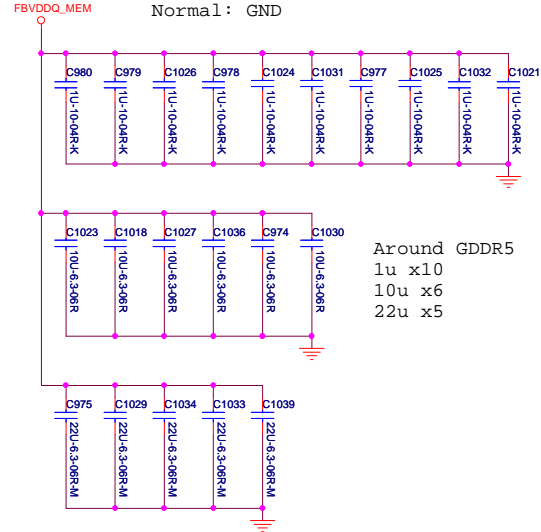
Sheet
62 of 72

[illegible][illegible][illegible]

MEM_FBC[31_0]

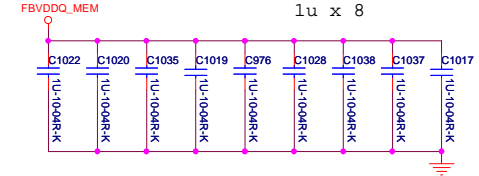


Mirrored: Pull high to VDDQ
Normal: GND



Around GDDR5
1u x 10
10u x 6
22u x 5

Under GDDR5
1u x 8



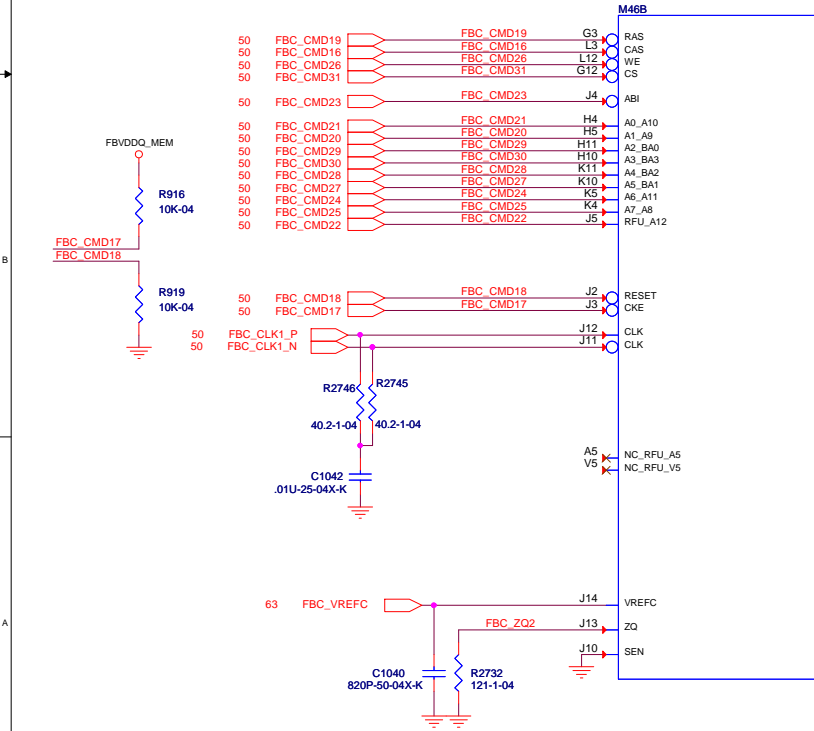
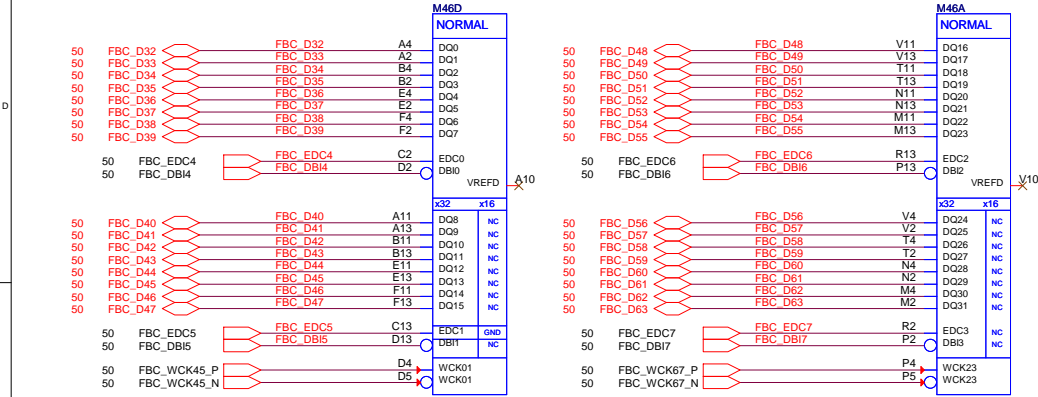
Tong Fang(Suzhou)
Export Processing Zone, No.200 Central Su-Hong Road
Suzhou Industrial Park, China
TEL:0512-62829228 <OrgAdd>

Title: **Frame Buffer C0-VRAM**

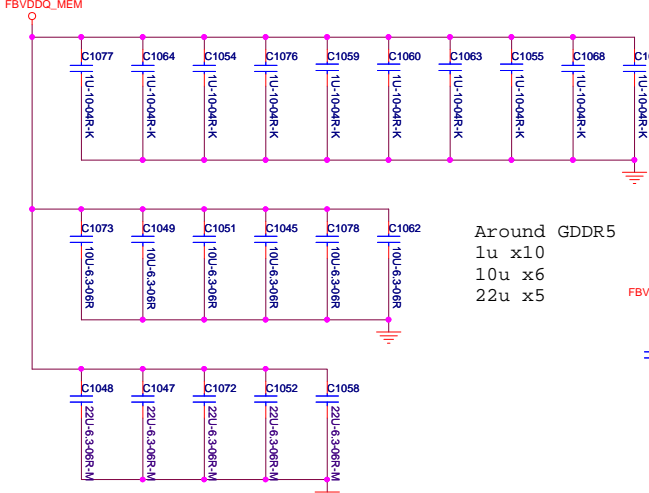
Size: Document Number: **GK5CN6X** Rev: V A

Date: Wednesday, October 25, 2017 Sheet: 63 of 72

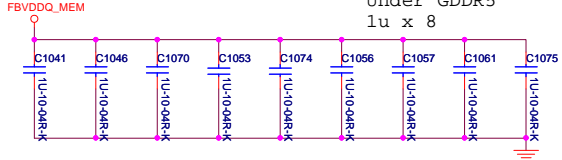
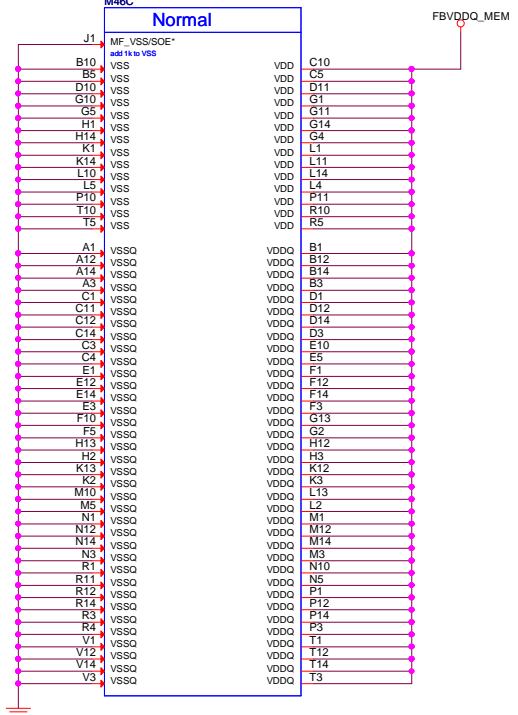
MEM_FBC[63_32]



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Around GDDR5
1u x10
10u x6
22u x5



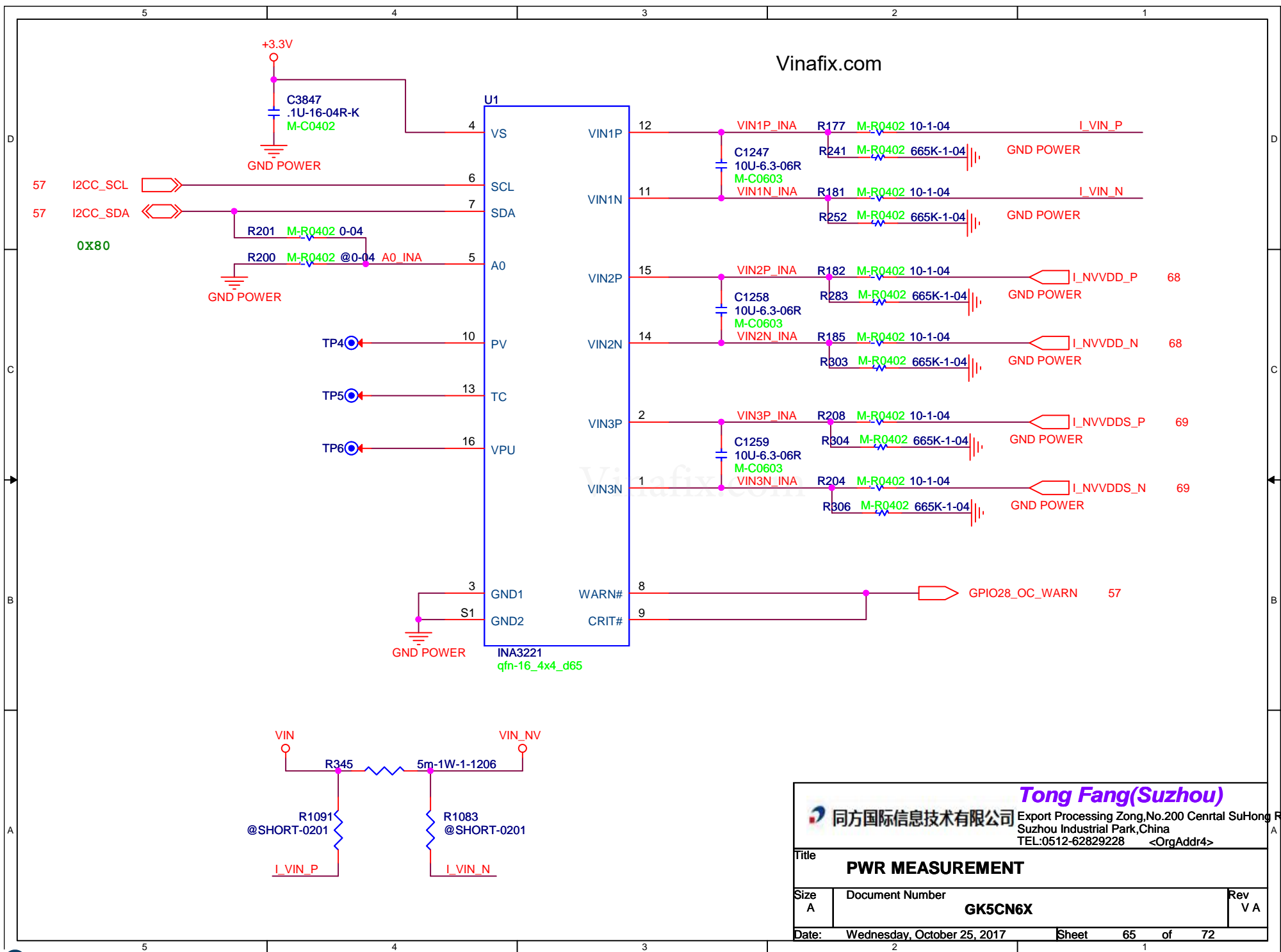
Under GDDR5
1u x 8

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TEL:0512-62829228 <OrgAdd>

Title: **Frame Buffer C1-VRAM**

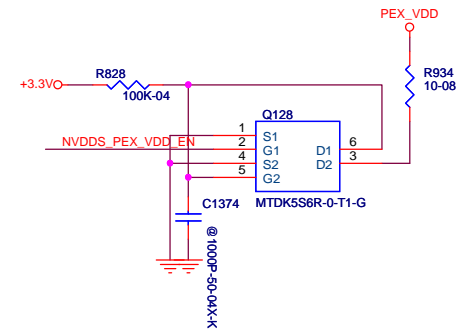
Size: Custom Document Number: **GK5CN6X** Rev: V A

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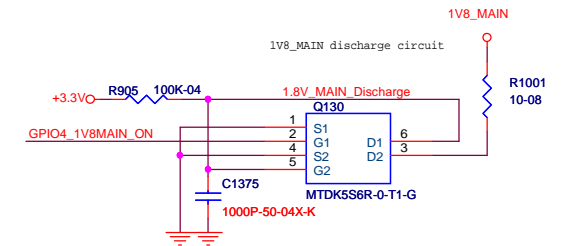


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Title PWR MEASUREMENT		
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PEX_VDD Converter



1V8_AON/1V8_MAIN



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		Title		
		DGPU PEX_VDD/1V8_AON		
Size B	Document Number		GK5CN6X	Rev V A
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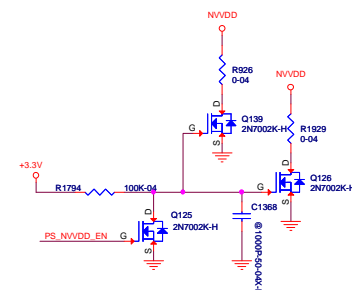
PSI	Mode
1.8V	Multi phase CCM
1.2V	Multi phase DCM
0.6V	Single-Phase CCM
0	Single-Phase DCM

57 GPIO6_NVVDD_PSI*

```

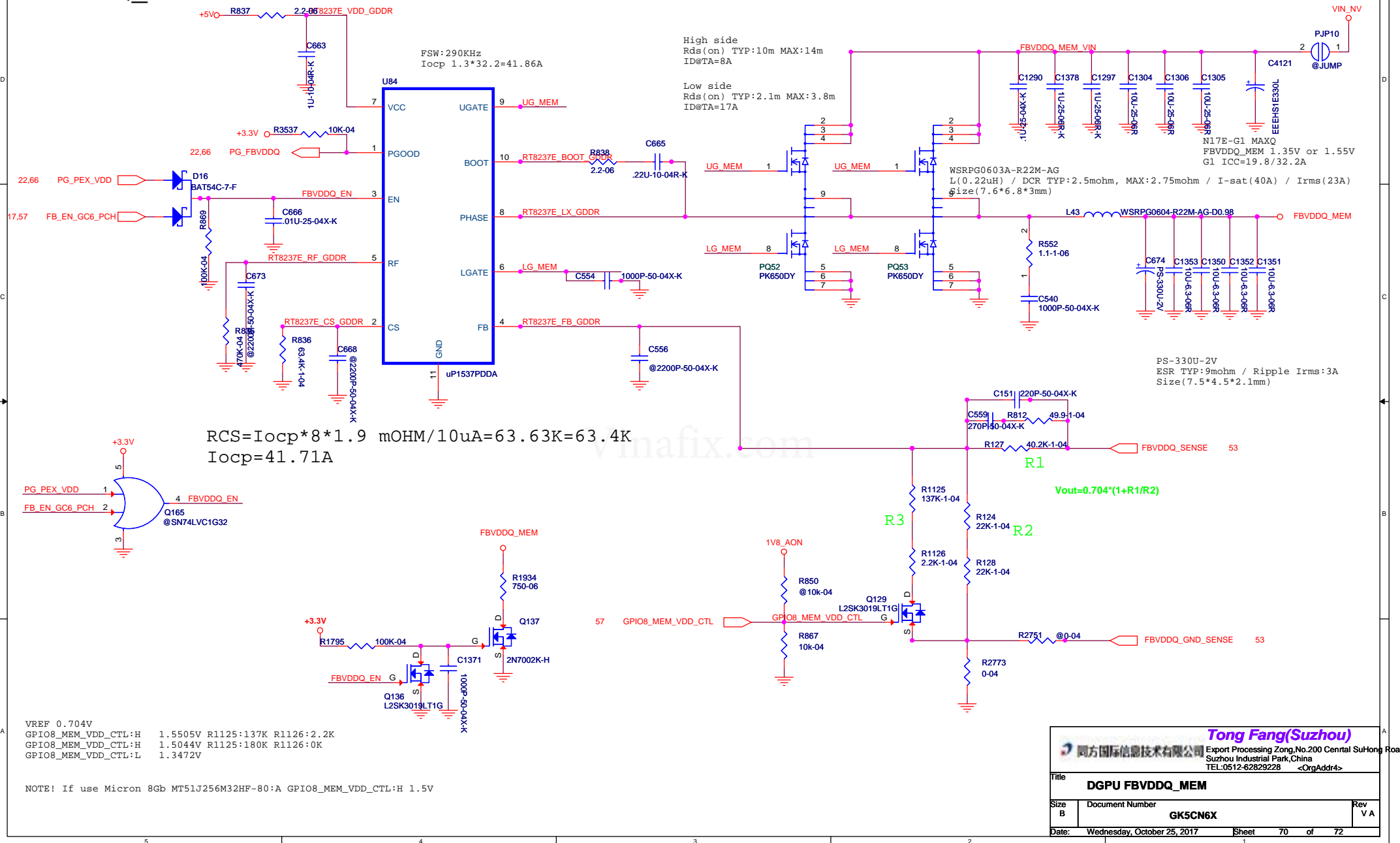
PWM VID:
VID=0%   Vout=0.7V(MIN)
VID=100% Vout=1.2V(MAX)

```



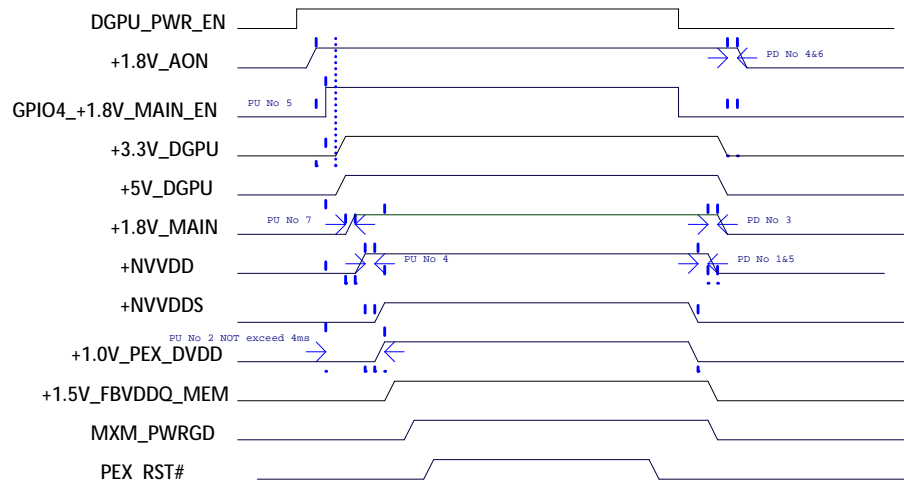
[illegible]

FBVDDQ_MEM



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GPU FBVDDQ_MEM	
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POWER SEQUENCE



POWER UP sequence is required: +1.8V_AON->+1.8V_MAIN->+NVVDD->+NVVDDS/+1.0V_PEX_DVDD->+1.5V_FBVDDQ_MEM

1. The ramp time for any rail must be more than 40us and is recommended to be less than 2ms.
2. t₁ From +1.8V_MAIN_EN to +1.0V_PEX_DVDD/+NVVDD_PGOOD) must NOT exceed 4ms.
3. The ramp-up overshoot should not exceed the silicon reliability limit voltage
4. Power up +NVVDD must be 90% before +1.0V_PEX_DVDD and NVVDDS can start ramp up.
5. Power up +1.8V_AON must be 90% before 3.3V ramp up.
6. All 3.3V devices that connect to the GPU must be powered after +1.8V_AON ; GPU can't have any 3.3V leakage path before +1.8V_AON present.
7. The propagation delay between +1.8V_MAIN_EN and the NVVDD_EN pin needs to be less than 300us during both power up and power down.

POWER DOWN sequence is required

1. +NVVDDS/+1.0V_PEX_DVDD must ramp down before NVVDD.
2. All other power rails can ramp down together with NVVDD.
3. +1.8V_MAIN must power down after NVVDD power down
3. The propagation delay between +1.8V_MAIN_EN and the NVVDD_EN pin needs to be less than 300us during both power up and power down.
4. All 3.3V devices that connect to the GPU must be ramp down before +1.8V_AON; GPU can't have any 3.3V leakage path after +1.8V_AON and +1.8V_MAIN power down.
5. Power down NVVDDS and +1.0V_PEX_DVDD must be less than 10% before NVVDD can start ramp down.
6. Power down 3.3V must be less than 10% before +1.8V_AON can start ramp down.

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Title DGPU POWER SEQUENCING	
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Date Chang History

20170916
FB_EN_GC6_PCH from GPP_K0 to GPP_K10
P17 remove pull low
P22 remove pull high

20171010

- 1、删除Mini DP, HPD diode
- 2、增加RJ45, transform
- 3、修改成GJ power 小板
- 4、修改成GJ USB2.0小板
- 5、修改成GJ Audio小板
- 6、增加led
- 7、增加power SW
- 8、将wlan led GPIO改成ID_det
- 9、增加USB3.0x2 on borad
- 10、增加usb2.0x3
- 11、增加LID线路
- 12、增加Q-key1 SWx2
- 13、修改DDR CN1、CN11 footprint
- 14、删除hole H7、H9、H22
- 15、删除PQ45、C1430
- 16、修改USB3
- 17、修改HDMI、type-c footprint
- 18、增加H7、H9, 删除H26
- 19、增加c4117、c4118、c4119、c4120、c4121
- 20、更新HDMI、type-c footprint
- 21、更新c4117、c4118、c4119、c4120、c4121 footprint
- 22、更新cn14、cn9 footprint
- 23、更新cn12、cn34 footprint
- 24、更新m.2、mini、bat conn footprint
- 25、更改GPIO扣, chg-o-led变成tp led; fanboost变成 c cover
- 26、更新SW6、led1、led2、led4、cn41、cn19、cn42、sw1、sw2、sw3、cn30、cn17、cn18等footprint
- 27、修改AUX-off线路
- 28、增加GPE1为VRA-PE
- 29、修改PCE5、PCE6电容为.1u
- 30、修改RJ45 pin number
- 31、删除H9, L24、L25、L26、L27垂直swap
- 32、修改L3, L10, L11, L28, L43的value footprint
- 33、删除NVDD和NVDS co-lay
- 34、增加EC_lanwake
- 35、lanwake和wlanwake softstart
- 36、更改gpio lanwake
- 37、增加c1453、c1439、c1449、c1459
- 38、C3990, C3991的value改成22U-6.3-06R-M, footprint: M-C0603
- 39、更新c4117、c4118、c4119、c4120 footprint
- 40、修改L12、L14、L15、L17

 同方国际信息技术有限公司		Tong Fang(Suzhou)	
Export Processing Zone, No.200 Central Su-Hong Road		Suzhou Industrial Park, China	
TEL:0512-62829228		<OrgAddit>	
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+5VS

PWR LED

Charge LED

Light bar Control

C cover light

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